Railway Recruitment Board **RRRBJE Electronics and Allied Engineering** Chapterwise Solved Papers

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	Relays	
	Switches	
	MCB & Connectors	
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	Thyristor	
	Diode and Triode Circuits	
	Junction Transistors	
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SYLLABUS RRB JE CBT-2 Electronics Engineering

- Electronic Components & Materials: Conductors, Semiconductor& Insulators; magnetic materials; jointing & cleaning materials for U/G copper cable & OFC; Cells and Batteries (Chargeable and non chargeable); Relays, Switches, MCB & Connectors.
- **Electronic Devices and circuits:** PN Junction diodes, thyristor; Diode and triode circuits; Junction Transistors: Amplifiers; Oscillator; multivibrator, counters; Rectifiers; Inverter and UPS.
- Digital Electronics: Number system and Binary codes; Boolean Algebra & Logic gates; Combinational & Sequential logic circuits; A/D & D/A Converter, counters, Memories.
- □ Linear Integrated Circuit: Introduction to operational Amplifier, Linear applications; Non-Linear applications, Voltage regulators, Timers; Phase lock loop.
- **Microprocessor and Microcontroller:** Introduction to microprocessor, 8085 microprocessor working; Assembly Language programming; Peripherals & other microprocessors; Microcontroller.
- **Electronic Measurements:** Measuring systems; Basic principles of measurement, Range Extension methods, Cathode ray oscilloscope, LCD, LED panel, Transducers.
- □ **Communication Engineering:** Introduction to communication; Modulation techniques; Multiplexing Techniques Wave propagation, Transmission line characteristic, OFC; Fundamentals of Public Address systems, Electronic exchange, Radar, Cellular and Satellite communication.
- Data communication and Network: Introduction to data communication, Hardware and interface; Introduction to Networks and Networking devices; Local Area Network and Wide area Network; Internet working.
- □ **Computer Programming:** Programming concepts; Fundamentals of 'C' and C⁺⁺; Operators in 'C' and C⁺⁺; Control Statements; Functions, Array String & Pointers, File Structure; Data Structure and DBMS.
- **Basic Electrical Engg:** DC Circuits; AC fundamentals; Magnetic, Thermal and Chemical effects of Electric current; Earthing-Installation, Maintenance, Testing.

NE-01 (UPMRCL) SCTO

Electrical/Electronics & Telecommunication

■ <u>BASIC ELECTRICAL ENGINEERING</u>

Basic concepts and principles of D.C and A.C fundamental, A C circuits, batteries, electromagnetic induction etc. including constant voltage and current sources.

■ ANALOG ELECTRONICS

Fundamental concepts of basic electronics and basic understanding of conductors, semiconductors and insulators, extrinsic and intrinsic semi-conductors, p-n junction, need of rectifiers in electronics, understanding of filters in rectifiers, tunnel diodes, LEDs, varactor diodes, LCD; working of transistors in various configurations; Concept of FETs and MOSFET etc.

CONTROL SYSTEMS

Basic elements of control system, open loop control system, closed loop control system, control system terminology, manually controlled closed loop systems, automatic controlled closed loop systems, basic elements of a servo mechanism, Examples of automatic control systems, use of equivalent systems for system analysis, linear systems, non-linear systems, control system examples from chemical systems, mechanical systems, electrical systems, introduction to Laplace transform. Transfer function analysis of ac and dc servomotors synchros, stepper motor, amply dyne. ac position control system, magnetic amplifier. Control system representation: Transfer function, block diagram, reduction of block diagram, problems on block diagram, Mason's formula signal flow graph Time Response Analysis : Standard test signals, time response of first and second-order system, time constant, time response of second order system. Stability: Routh Hurwitz Criterion, Root Locus, Bode Plotting using semi log graph paper Introduction to multiloop control system and its types, feed forward, cascade, ratio, split range, control system. Study of different processes using above mentioned control systems Non-Linear Control System : Introduction, behaviour of non-linear control system. Different types of nonlinearities, saturation, backlash, hysteresis, dead zone, relay, fiction, characteristics of non-linear control system, limit cycles, jump resonance, jump phenomenon. Difference between linear and non-linear control system.

<u>ELECTRONIC COMPONENTS AND MATERIALS</u>

Materials : Classification of materials , Conducting, semi-conducting and insulating materials through a brief reference to their atomic structure.

Conducting Materials : Resistors and factors affecting resistivity such as temperature, alloying and mechanical stressing. Classification of conducting materials into low resistivity and high resistivity materials.

Insulating Materials : Important relevant characteristics (electrical, mechanical and thermal) and applications of the following material: Mica, Glass, Copper, Sliver, PVC, Silicon, Rubber, Bakelite, Cotton, Ceramic, Polyester, Polythene and Varnish.

Magnetic Materials : Different Magnetic materials; (Dia, Para, Ferro) and their properties. Ferro magnetism, Domains, permeability, Hysteresis loop. Soft and hard magnetic materials, their examples and typical applications.

MEASURING INSTRUMENTS

Introduction to Testing and Measurements, Measurement of Resistance, Inductance and Capacitance, Ammeter, Voltmeter and Multimeter, Power and Energy Measurements, Frequency and Phase difference Measurement

PRINCIPLES OF INSTRUMENTATION

Basic building blocks of any instrumentation systems, Performance characteristics of Oscillator Instruments, Instrument selection: Factors affecting instrument selection, accuracy, precision, linearity, resolution, sensitivity, hysteresis, reliability, serviceability, loading effect, range advantage and limitation, cost effectiveness and availability - Static and dynamic response - Environmental effects - Calibration tools

<u>FUNDAMENTALS OF DIGITAL ELECTRONICS</u>

Concepts of Digital electronics, Number system, gates, codes, arithmetic logic circuits, flip-flops, shift resistors and counters.

BASIC OF Microprocessors

Architecture of a typical microprocessor, configurations and instructional pair configuration systems and working of various peripheral interface chips. 8085 Microprocessors, architecture, instruction sets and introduction to 8086.

POWER ELECTRONICS

Introduction to thyristors and other power Electronics devices, Controlled Converters, Inverters, Choppers.

COMPUTER AIDED INSTRUMENTATION

Computer aided Instrumentation, Buses and Standards : Introduction, BUS types : The I/O BUS a) ISA bus b) EISA Bus c) PCI bus, GPIB 2.5 RS-232, Linear Circuits and Signal Conditioning, Parallel Port (PP) Interfacing Techniques, Serial Port (SP) Interfacing Techniques, USB Port Interfacing Techniques.

QUALITY AND RELIABILITY TECHNIQUES

Quality organization and Management: Introduction, Quality Policy, Task for Quality and Introduction to Total Quality Systems

Quality costs : Prevention costs, appraisal costs, internal failure costs, external failure costs, impact of quality costs on profitability

Basic Electrical Engg. And Electt. Measurements:

Concepts of currents, Voltage, Resistance, Power and energy, their units, Ohm's law. Circuit Law: Kirchhoff's law Solution of simple network problems, Network theorems and their applications, Electro-magnetism concept of flux, Emf, Reluctance, Magnetic circuits, Electro-magnetic induction, Self and mutual inductance., A.C. fundamentals Instantaneous, Peak, R.m.s. And average values of alternating waves, Equation of sinusoidal wave form, Simple series and parallel a.c. Circuits consisting of R.L. and C. Resonance, Measurement and measuring instruments Moving coil and moving iron ammeters and voltmeters, Extension of range, Watt meters, Multimeters, Megger, Basic Electronics.

Electrical machines:

Basic principles D, C motors of generators, their characteristics, Speed control and starting of D.C. motors, Losses and efficiency of D.C. machines.

■ <u>1-phase and 3-phase Transformers:</u>

Principles of Operation, Equivalent Circuit, Voltage Regulation O.C. And S.C. Tests, Efficiency, Auto Transformers, Synchronous Machines, Generation Of Three Phase Emf, Armature Reaction, Voltage Regulation, Parallel Operation Of Two Alternators, Synchronizing, Staring And Applications Of Synchronous Motors, 3-Phase Induction Motor, Rotating Magnetic Field, Principle Of Operation, Equivalent Circuit, Torque Speed Characteristics, Starting And Speed Control Of 3-Phase Induction Motors, Fractional Kw Motors, 1-Phase Induction Motors A.C. Series Motor, Reluctance Motor.

General, Transmission and Distribution:

Different types of power stations, Load factor, Diversity factor, Demand factor, Simple problems thereon, Cost of generation inter connection of power stations, Power factor improvement, Various types of tariffs, Types of faults Short circuit current for symmetrical faults, Switchgears-rating of circuit breakers: Principles of a arc extinction by oil and air, H.R.C. fuses, Protection earthier leakage, Over current Buchhotgz relay Merz-Prince system of protection of generators & transformers, Protection of feeders and bus bars., Lightning arresters, Various transmission and distribution systems, Comparison of conductor materials. Efficiency for different systems.

Utilization of Electrical Energy:

Illumination, Electric heating, Electric welding, Electroplating, Electric drivers and motors.

Electronics Engineering Previous Years Papers Analysis Chart

S.N.	EXAM NAME	EXAM DATE	No. of Questions	
DEDICATED FREIGHT CORRIDOR CORPORATION OF INDIA LIMITED (DFCCIL)				
1.	DFCCIL S&T	17.12.2023	1×60	
2.	DFCCIL Executive	20.12.2023	1×96	
3.	DFCCIL S&T	29.09.2021	1×96	
4.	DFCCIL Electrical	30.09.2021	1×96	
5.	DFCCIL Electrical	11.11.2018	1×96	
6.	DFCCIL Electrical	17.04.2016	1×80	
7.	DFCCIL S&T	17.04.2016	1×80	
	UTTAR PRADESH METRO RAII	CORPORATION (UPMRC)		
8.	UPMRC JE (S&T)	03.01.2023	1×90	
9.	LMRC SCTO Shift-II	17.04.2021	1×90	
10.	LMRC JE (S&T) Shift-III	20.01.2020	1×90	
11.	LMRC JE S&T	12.05.2018	1×90	
12.	LMRC SCTO	16.04.2018	1×90	
13.	LMRC JE	17.03.2016	1×90	
14.	LMRC SCTO Shift-I	17.03.2016	1×90	
15.	LMRC JE	26.06.2015	1×90	
	DELHI METRO RAIL CORPORA	TION(DMRC)/NMRC/JMRC		
16.	DMRC JE Electronics (Contract)	23-02-2020	1×75	
17.	DMRC JE Electronics (Regular)	2020	1×75	
18.	DMRC JE Electronics Shift-II	19.4.2018	1×75	
19.	DMRC JE Electronics Shift-II	11.4.2018	1×75	
20.	DMRC JE Electronics Shift-III	11.04.2018	1×75	
21.	DMRC JE Electronics Shift-I	17.2.2017	1×75	
22.	DMRC JE Electronics Shift-II	17.02.2017	1×75	
23.	DMRC JE Electronics Paper-I	06.03.2016	1×75	
24.	DMRC JE Electronics Paper-I	15.03.2015	1×75	
25.	DMRC JE Electronics Paper-I	21.09.2014	1×75	
26.	NMRC BECIL	2019	1×45	
27.	NMRC JE Electronics	2017	1×75	
28.	NMRC JE Electrical	2017	1×75	
29.	JMRC	2021	1×48	

RAILWAY RECRUITMENT BOARD (RRB)-2019			
30.	RRB JE 2019	31.08.2019	1×150
31.	RRB JE 2019	01.09.2019	1×150
	RAILWAY RECRUITMENT	BOARD (RRB)-2015	
32.	RRB SSE Shift –I	01.09.2015	1×20
33.	RRB SSE Shift –II	01.09.2015	1×21
34.	RRB SSE Shift –III	01.09.2015	1×21
35.	RRB SSE Shift –I	02.09.2015	1×22
36.	RRB SSE Shift –II	02.09.2015	1×20
37.	RRB SSE Shift –III	02.09.2015	1×21
38.	RRB SSE Shift –I	03.09.2015	1×22
39.	RRB SSE Shift –II	03.09.2015	1×20
40.	RRB SSE Shift –III	03.09.2015	1×20
41.	RRB J.E Shift –II	04.09.2015	1×21
42.	RRB J.E Shift –III	16.09.2015	1×22
43.	RRB J.E Shift –I	26.08.2015	1×22
44.	RRB J.E Shift –II	26.08.2015	1×21
45.	RRB J.E Shift –III	26.08.2015	1×20
46.	RRB J.E Shift –I	27.08.2015	1×22
47.	RRB J.E Shift –II	27.08.2015	1×21
48.	RRB J.E Shift –III	27.08.2015	1×20
49.	RRB J.E Shift –I	28.08.2015	1×22
50.	RRB J.E Shift –II	28.08.2015	1×19
51.	RRB J.E Shift –III	28.08.2015	1×21
52.	RRB J.E Shift –I	29.08.2015	1×20
53.	RRB J.E Shift –II	29.08.2015	1×22
54.	RRB J.E Shift –III	29.08.2015	1×22
55.	RRB J.E Shift –III	30.08.2015	1×21
	RAILWAY RECRUITMENT	BOARD (RRB)-2014	
56.	RRB JE Allahabad	2014	1×22
57.	RRB JE Gorakhpur	2014	1×23
58.	RRB JE Chandigarh	2014	1×22
59.	RRB JE Jharkhand	2014	1×21
60.	RRB JE Guwahati	2014	1×22
61.	RRB JE Bhopal	2014	1×23
62.	RRB JE Ahmedabad	2014	1×20
63.	RRB JE Ajmer	2014	1×21
64.	RRB SSE Green Paper (Bilaspur, Secunderabad)	21.12.2014	1×21
65.	RRB SSE Yellow Paper (Bilaspur, Secunderabad)	21.12.2014	1×22
66.	RRB SSE Red Paper (Bilaspur, Secunderabad	21.12. 2014	1×23

OTHER RAILWAY JE & SSE Exams.			
67.	RRB Allahabad JE 2010	19.12.2010	1×25
68.	RRB Allahabad SSE 2010	19.12.2010	1×23
69.	RRB Mumbai JE 2008	05.10.2008	1×28
70.	RRB Mumbai SSE 2008	05.10.2008	1×31
71.	RRB Mumbai JE 2010	19.12.2010	1×22
72.	RRB Mumbai SSE 2010	19.12.2010	1×26
73.	RRB Bhubaneswar JE-II 2010	19.12.2010	1×20
74.	Konkan Railway STA 2017	2017	1×24
75.	Konkan Railway TA 2017	2017	1×18
76.	Konkan Railway SSE 2015	2015	1×31
77.	RRB Kolkata Diesel JE 2009	25.10.2009	1×23
78.	RRB Chandigarh SSE 2009	25.10.2009	1×26
79.	RRB Mumbai C&G JE 2009	25.10.2009	1×24
80.	RRB Gorakhpur RDSO SSE 2009	25.10.2009	1×25
81.	RRB Jammu JE 2009	25.10.2009	1×23
82.	RRB Malda SSE 2009	25.10.2009	1×27
83.	RRB Allahabad JE 2009	25.10.2009	1×21
84.	RRB Mumbai C&G SSE 2009	25.10.2009	1×26
85.	RRB Patna JE	25.10.2009	1×23
86.	RRB Bhopal TM SSE 2009	25.10.2009	1×24
87.	RRB Allahabad SSE 2012	09.09.2012	1×25
88.	RRB Bangalore SSE 2012	09.09.2012	1×29
89.	RRB Kolkata SSE 2012	09.09.2012	1×18
90.	RRB Gorakhpur Design SSE 2012	09.09.2012	1×23
91.	RRB Bhopal SSE 2012	09.09.2012	1×25
92.	RRB Chandigarh SSE 2012	09.09.2012	1×28
93.	RRB Jammu SSE 2012	09.09.2012	1×23
94.	RRB Allahabad JE 2012	09.09.2012	1×21
95.	RRB Bhubaneswar JE II 2008	29.11.2008	1×25
96.	Konkan Railway STA 2017	2017	1×23
97.	Konkan Railway TA 2017	2017	1×24
98.	Konkan Railway SSE 2015	2015	1×20

99.	RRB Kolkata Diesel JE 2009	25.10.2009	1×22
100.	RRB Bhopal Section Engineer,	24.11.2002	1×24
101.	RRB Bhopal & Mumbai Apprentice Section Engg.	23.03.2003	1×28
102.	RRB Secunderabad Section Engineer (Elect.)	29.06.2008	1×22
103.	RRB Bangalore Section Engineer (Elect.)	01.02.2009	1×23
104.	RRB Chandigarh Section Engineer,	15.03.2009	1×25
105.	RRB Chennai Section Engineer,	12.02.2012	1×27
106.	RRB Chandigarh Section Engineer (Elect.)	26.02.2012	1×24
107.	RRB Chandigarh Section Engineer,	26.02.2012	1×29
108.	RRB Jammu Section Engg., 2013	2013	1×20
109.	RRB Bhubaneswar Section Engineer (Electrical)	19.08.2001	1×18
110.	RRB Kolkata Engineer	20.02.2000	1×15
111.	RRB Kolkata Apprentice Engineer	14.10.2001	1×20
112.	RRB Bangalore Material Engineer	21.11.2004	1×21
113.	RRB Kolkata Mech. Engineer	06.02.2005	1×15
114.	RRB Allahabad Junior Engineer-II	08.01.2006	1×15
115.	RRB Kolkata Jr. Engineer-II Electrical DRG & Design,	11.06.2006	1×15
116.	RRB Kolkata Technical- Engineer	20.08.2006	1×28
117	RRB Chennai Technical (Engineer)	15.04.2007	1×25
118.	RRB Bangalore Technical (Engineer)	22.04.2007	1×27
119.	RRB Secunderabad Technical (Engg.)	20.05.2007	1×22
120.	RRB Patna Technical Engineer,	27.07.2008	1×28
121.	RRB Thiruvananthapuram Section Eng.	04.01.2009	1×19
122.	RRB Bangalore Section Engineer	01.02.2009	1×23
123.	RRB Chandigarh Section Engineer	15.03.2009	1×26
124.	RRB Chandigarh Section Engineer	26.02.2012	1×27
125.	RRB Bhopal Section Engineer	24.11.2002	1×20
Total			4742

Trend Analysis of Electronics Questions Through Pie Chart and Bar Graph







Electronic Components and Materials

■ Conductors ■ Semiconductor & Insulators ■ Magnetic materials ■ Jointing & cleaning materials for U/G copper cable & OFC ■ Cells and Batteries (Chargeable and non chargeable) ■ Relays ■ Switches ■ MCB & Connectors.

(i) Conductors	5. Which of the following material has the highest electrical conductivity?
1 The most commonly used electrical conductor	(a) Gold (b) Silver
is-	(c) Copper (d) Aluminium
(a) Lead (b) Copper	RRB Chennai technical (Engg.) 15.04.2007
(c) Brass (d) Tin	Ans. (b) : A conductor is a material which gives very
RRB JE- 01.09.2019	little resistance to the flow of an electric current.
RRB Bhubaneswar JE-II 29.11.2008	Silver has the highest electrical conductivity out of all
Ans. (b) : The most commonly used electrical	material. The decreasing order of conductivity is Silver
conductor is copper. Copper is a metal which has high	
conductivity and low resistivity.	6. 5×10^{10} electrons pass across the section of a
• It is easily available.	flowing is :
• Resistivity of copper is 1.//×10 ⁻ onm-meter.	(a) $1 \text{ m} \Delta$ (b) $0 1 \text{ m} \Delta$
• Melting point of copper is 1084°C.	(a) 1 mA (b) 0.1 mA (c) 0.01 mA (d) 10 mA
2. Which material has the highest electrical	RRB SSE (shift-III), 02.09.2015
conductivity:	Ans : (b) $O = it$ and $O = ne$ where $e = 1.6 \times 10^{-19} C$
(a) Aluminium (b) Steel (c) Silver (d) Lead	$5 \times 10^{16} \times 10^{-19}$
(d) Edd RRB JE 31.08.2019	$i = \frac{he}{m} \Rightarrow \frac{5 \times 10^{-10} \times 1.6 \times 10^{-10}}{m} = 0.1 \text{ mA}$
RRB Mumbai 2015	t 80
Ans. (c) : Silver has the highest electrical conductivity.	7Are usually found in the nucleus of an
It is a conducting material with a large number of free	atom
electrons. Due to large number of free electron it has a	(a) Proton and Neutron
night electrical conductivity. The resistivity of sliver is 1.50×10^{-8} Om and the conductivity is 6.20×10^{7} O ⁻¹ m ⁻¹	(b) Proton and Electron (c) Electron and Neutron
1.59×10^{-10} sin and the conductivity is 0.29×10^{-10} sin	(c) Election and Neutron (d) Only Neutron
3. A conductor is said to be perfect if it has	$\mathbf{RRB A imer Flectronic} = 2014$
(a) Zero (b) Finite	Ans : (a) Generally, the nucleus of an atom consists of
(c) Infinite (d) Unity	protons and neutrons. Electrons in revolve in outside the
RRB JE 31.08.2019	nucleus.
Ans. (c) : A conductor is said to be perfect if it has	8. Which of the following is not one of the effects
infinite electrical conductivity. Conductor are those	of rise in temperature on resistance?
substances in which the number of free electron is very	(a) Decrease in the resistance of pure metals
high ($\simeq 10^{22}$ per unit volume)	(b) Increase in the resistance of alloys
Silver is the best conductor of electricity because it	(c) Decrease in the resistance of electrolytes,
contains a nigher number of free electrons.	insulators, etc.
4. A material is said to have become superconductor	(d) increase in the resistance of pure metals
(a) its resistance becomes negative	KKD JAIIIIIU JE-23.10.2009 DECCIL, Evolutivo (FE) _30.00.2021
(b) its resistance becomes very small	Ang (a): Dura motol (conductor) has positiva
(c) its resistance decreases	Alls.(a): Pule metal (conductor) has positive
(d) its resistance becomes zero	resistance also increases
RRB SSE Bilaspur Yellow paper, 21.12.2014	• The composition of constanton is:
Ans : (d) A material is said to have become	(a) $C_{\rm u} = 60\%$ and $N_{\rm i} = 40\%$
superconductor when its resistance becomes zero. A	(a) $Cu = 0070$ and $101 + 0700$ (b) $Cu = 43\%$ Ni = 17% and Mn = 40%
superconductor is a material that attains,	(c) $Sn = 23.43\%$ Cu = 43.67% and Ni = 32.9%
Superconductivity a state of matter with no electrical	(d) $Mn = 65\%$ and $Zn = 35\%$
resistance. In a superconductor an electric current can	UPMRC JE- 20.01.2020. 4:00 to 6:00 PM
persist indefinitely.	DMRC Electronics 17.02.2017, 12:00 – 2:15 PM
For Superconducting material $(\mu_r) = 0$, Susceptibility	Delhi Metro Electronics JE 2017
$(\chi) = \text{Negative},$	RRB Bhopal SSE 24.11.2002
Electronic Component and Materials	11 YCT

Ans. (a) : Constantan:- It used in the production of ther	is a copper and nickel alloy mocouples and thermocouple	Ans. (d) : Silver tungsten contact material has high thermal and electrical conductivity.
extension wire as well as precision resistor and two		15. The correct sequence of increasing order of
temperature resistance heating application.		electrical resistivity of the given material is-
Constantan = $Cu (60\%) + Ni (40\%)$		(a) Diamond, Silicon, Gold, Doped germanium
10. Metal film resistors	are made by depositing a	(b) Gold, Silicon, Doped germanium, Diamond
very thin layer of me	tal on–	(c) Gold, Doped germanium, Silicon, Diamond
(a) Metal rod	(b) Bakelite sheet	(d) Gold Diamond, Doped germanium, Silicon
(C) Ceramic rou RRR Bhu	(d) Wieldi Sheel baneswar IF-II 29 11 2008	Konkan Railway TA-2017
Ans : (b) Metal film resisto	rs are made by denositing a	Ans. (c) : Electrical resistivity (also called specific
very thin layer of metal on B	akelite Sheet	electrical resistance or volume resistivity) and it is
11 In the superconducti	ng state the flux lines of a	reciprocal of electrical conductivity, and it is a
magnetic field ar	e ejected out of the	strongly it resists of the electric current. The SI unit of
superconductor as no	or_	electrical resistivity is the ohm-meter Increasing order
(a) Curie effect	(b) Faraday's effect	of electrical resistivity of materials. Gold. Doped
(c) Maxwell's effect	(d) Meissner effect	Germanium, Silicon, Diamond.
RRB C	Chandigarh SSE 15.03.2009	16. The best definition of a superconductor is:
Ans. (d) : In the supercondu	icting state the flux lines of	(a) It is a material showing perfect conductivity
a magnetic field are ejected	out of the super conductor	and Meissner effect below a critical
as per Meissner effect. The M	Meissner effect is a property	temperature
of all superconductor was	discovered by the German	(b) It is conductor having zero resistance
Physicists W. Meissner and	R. Ochsenfeld in 1933.	(c) It is a perfect conductor with highest
12. The usual matter of s	oldering is	diamagnetic susceptibility
(a) Steel alloy		(d) It is a perfect conductor but becomes resistive
(b) White metal	,•	when the current density through it exceeds
(c) Alloy of lead and	tin d _in a	
(d) Alloy of copper a	nd ZIIIC Daneswar IF_II 10 12 2010	DIVINCE JE 24.02.2017
Ans (a) · The usual matter	of soldering is allow of lead	superconductivity which is a state of matter that has no
and tin Those allows which	work to join two or more	electrical resistance and does not allow magnetic field
metallic pieces or small	work item by melting	to penetrate.
themselves due to heat that is called solder material		
themselves due to heat that i	s called solder material.	Superconductor is a material showing perfect conductivity
themselves due to heat that i 1. Tin and lead less than	s called solder material. soft solder (melting point	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature.
themselves due to heat that i 1. Tin and lead less than 40°C)	s called solder material. soft solder (melting point	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity -
themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po	s called solder material. soft solder (melting point int above 400°C	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity -
themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 2	s called solder material. soft solder (melting point int above 400°C Zinc	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_{a} = H_{a} \left[1 - \left(\frac{T^{2}}{T^{2}} \right) \right]$
 themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 12 	s called solder material. soft solder (melting point int above 400°C Zinc silver	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_{c} = H_{c(0)} \left[1 - \left(\frac{T^{2}}{T_{c}^{2}} \right) \right]$
themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 13. Which of the follo silver aluminium of the solder - Copper +	s called solder material. soft solder (melting point int above 400°C Zinc silver wing lists four platinum,	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_{c} = H_{c(0)} \left[1 - \left(\frac{T^{2}}{T_{c}^{2}} \right) \right]$ $H_{c} = critical value of magnetic field$
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themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 13. Which of the follor silver, aluminium a order of resistivity? (a) Platinum, Alumin (b) Silver, Copper, P (c) Copper, Silver, A (d) Silver, Copper, A Noida Metro Electron RRI Ans : (d) Material	s called solder material. soft solder (melting point int above 400°C Zinc silver wing lists four platinum, and copper in increasing hium, Copper, Silver latinum, Aluminium luminum, Platinum ic JE 2017, SAIL 29.3.2014 B Allahabad JE-19.12.2010 Resistivity (Ω-m)	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_c = H_{c(0)} \left[1 - \left(\frac{T^2}{T_c^2} \right) \right]$ $H_c = \text{critical value of magnetic field}$ $H_{c(0)} = \text{critical magnetic field at 0K}$ $T_c = \text{critical temperature}$ 17is a weak electron - electron bond pair mediated by a phonon interaction.
themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 13. Which of the follor silver, aluminium a order of resistivity? (a) Platinum, Alumir (b) Silver, Copper, P (c) Copper, Silver, A (d) Silver, Copper, A Noida Metro Electron RRI Ans : (d) Silver	s called solder material. soft solder (melting point int above 400°C Zinc silver wing lists four platinum, ind copper in increasing num, Copper, Silver latinum, Aluminium luminum, Platinum ic JE 2017, SAIL 29.3.2014 B Allahabad JE-19.12.2010 Resistivity (Ω -m) 1.59×10^{-8}	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_c = H_{c(0)} \left[1 - \left(\frac{T^2}{T_c^2} \right) \right]$ $H_c = \text{critical value of magnetic field}$ $H_{c(0)} = \text{critical magnetic field at 0K}$ $T_c = \text{critical temperature}$ 17. is a weak electron - electron bond pair mediated by a phonon interaction. (a) Electron pair (b) Cooper pair (c) Ion pair (c) Electron pair (c) Electron pair
themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 13. Which of the follor silver, aluminium a order of resistivity? (a) Platinum, Alumir (b) Silver, Copper, P (c) Copper, Silver, A (d) Silver, Copper, A Noida Metro Electron RRI Ans : (d) Silver Copper	s called solder material. soft solder (melting point int above 400°C Zinc silver wing lists four platinum, and copper in increasing hium, Copper, Silver latinum, Aluminium luminum, Platinum luminium, Platinum ic JE 2017, SAIL 29.3.2014 B Allahabad JE-19.12.2010 Resistivity (Ω -m) 1.59 × 10 ⁻⁸ 1.68 × 10 ⁻⁸	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_c = H_{c(0)} \left[1 - \left(\frac{T^2}{T_c^2} \right) \right]$ $H_c = \text{critical value of magnetic field at 0K}$ $T_c = \text{critical temperature}$ 17. is a weak electron - electron bond pair mediated by a phonon interaction. (a) Electron pair (b) Cooper pair (c) Ion pair (d) Fermions pair
themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 13. Which of the follor silver, aluminium a order of resistivity? (a) Platinum, Alumir (b) Silver, Copper, P (c) Copper, Silver, A (d) Silver, Copper, A Noida Metro Electron RRI Ans : (d) Silver Copper Gold	s called solder material. soft solder (melting point int above 400°C Zinc silver wing lists four platinum, and copper in increasing hium, Copper, Silver latinum, Aluminium luminum, Platinum luminum, Platinum ic JE 2017, SAIL 29.3.2014 B Allahabad JE-19.12.2010 Resistivity (Ω -m) 1.59 × 10 ⁻⁸ 1.68 × 10 ⁻⁸ 2.4 × 10 ⁻⁸	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_c = H_{c(0)} \left[1 - \left(\frac{T^2}{T_c^2} \right) \right]$ $H_c = \text{critical value of magnetic field}$ $H_{c(0)} = \text{critical magnetic field at 0K}$ $T_c = \text{critical temperature}$ 17is a weak electron - electron bond pair mediated by a phonon interaction. (a) Electron pair (b) Cooper pair (c) Ion pair (d) Fermions pair UPMRCL JE (S&T) 03.01.2023,1:30-3:30PM
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themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 2 (b) Silver solder - Copper + 2 (c) Silver, aluminium a order of resistivity? (a) Platinum, Alumin (b) Silver, Copper, P (c) Copper, Silver, A (d) Silver, Copper, A Noida Metro Electron RRI Ans : (d) Ans : (d) Silver Copper Gold Aluminium Tungsten	s called solder material. soft solder (melting point int above 400°C Zinc silver wing lists four platinum, and copper in increasing hium, Copper, Silver latinum, Aluminium luminum, Platinum luminum, Platinum ic JE 2017, SAIL 29.3.2014 B Allahabad JE-19.12.2010 Resistivity (Ω -m) 1.59 × 10 ⁻⁸ 1.68 × 10 ⁻⁸ 2.4 × 10 ⁻⁸ 2.88 × 10 ⁻⁸ 5.6 × 10 ⁻⁸	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_c = H_{c(0)} \left[1 - \left(\frac{T^2}{T_c^2} \right) \right]$ $H_c = \text{critical value of magnetic field}$ $H_c(0) = \text{critical magnetic field at 0K}$ $T_c = \text{critical temperature}$ 17. is a weak electron - electron bond pair mediated by a phonon interaction. (a) Electron pair (b) Cooper pair (c) Ion pair (d) Fermions pair UPMRCL JE (S&T) 03.01.2023,1:30-3:30PM Ans. (b) : Cooper pair is a weak electron - electron bond pair mediated by a phonon interaction. Electron-phonon interaction.
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themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 13. Which of the follor silver, aluminium a order of resistivity? (a) Platinum, Alumir (b) Silver, Copper, P (c) Copper, Silver, A (d) Silver, Copper, A Noida Metro Electron RRI Ans : (d) Material Silver Copper Gold Aluminium Tungsten Platinum Increasing order of resistivity	s called solder material. soft solder (melting point int above 400°C Zinc silver wing lists four platinum, and copper in increasing hium, Copper, Silver latinum, Aluminium luminum, Platinum luminum, Platinum ic JE 2017, SAIL 29.3.2014 B Allahabad JE-19.12.2010 Resistivity (Ω -m) 1.59 × 10 ⁻⁸ 1.68 × 10 ⁻⁸ 2.4 × 10 ⁻⁸ 2.88 × 10 ⁻⁸ 5.6 × 10 ⁻⁸ 10.6 × 10 ⁻⁸ V-	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_{c} = H_{c(0)} \left[1 - \left(\frac{T^{2}}{T_{c}^{2}} \right) \right]$ $H_{c} = \text{critical value of magnetic field}$ $H_{c(0)} = \text{critical magnetic field at 0K}$ $T_{c} = \text{critical temperature}$ 17. is a weak electron - electron bond pair mediated by a phonon interaction. (a) Electron pair (b) Cooper pair (c) Ion pair (d) Fermions pair UPMRCL JE (S&T) 03.01.2023,1:30-3:30PM Ans. (b) : Cooper pair is a weak electron - electron bond pair Electron-phonon interaction. Electron-phonon interaction. Electron-phonon interaction. Electron-phonon interaction. Electron-phonon interaction. Is a major scattering mechanism that
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themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 13. Which of the follor silver, aluminium a order of resistivity? (a) Platinum, Alumin (b) Silver, Copper, P (c) Copper, Silver, A (d) Silver, Copper, A Noida Metro Electron RRI Ans : (d) Ans : (d) Material Silver Copper Gold Aluminium Tungsten Platinum Increasing order of resistivity Silver, Copper, Alu 14. Silver tungsten	s called solder material. soft solder (melting point int above 400°C Zinc silver wing lists four platinum, and copper in increasing num, Copper, Silver latinum, Aluminium luminum, Platinum ic JE 2017, SAIL 29.3.2014 B Allahabad JE-19.12.2010 Resistivity (Ω -m) 1.59 × 10 ⁻⁸ 1.68 × 10 ⁻⁸ 2.4 × 10 ⁻⁸ 2.88 × 10 ⁻⁸ 5.6 × 10 ⁻⁸ 10.6 × 10 ⁻⁸ y - minium, Platinum. contact material has	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_{c} = H_{c(0)} \left[1 - \left(\frac{T^{2}}{T_{c}^{2}} \right) \right]$ $H_{c} = \text{critical value of magnetic field}$ $H_{c(0)} = \text{critical magnetic field at 0K}$ $T_{c} = \text{critical temperature}$ 17
themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 2 (c) Silver, aluminium a order of resistivity? (a) Platinum, Alumir (b) Silver, Copper, P (c) Copper, Silver, A (d) Silver, Copper, A Noida Metro Electron RRI Ans : (d) Material Silver Copper Gold Aluminium Tungsten Platinum Increasing order of resistivity Silver, Copper, Alu 14. Silver tungsten thermal and election (a) Silver and a construction (b) Silver, Copper, Aluminium Ans : (c) 14. Silver tungsten thermal and election (c) Silver Silver, Copper, Aluminium Ans : (c) (c) Silver Silver, Copper, Aluminium Silver, Copper, Aluminium Silver, Copper, Aluminium Silver, Copper, Aluminium Aluminium Silver, Copper, Aluminium Silver, Copper, Aluminium Sil	s called solder material. soft solder (melting point int above 400°C Zinc silver wing lists four platinum, and copper in increasing num, Copper, Silver latinum, Aluminium luminum, Platinum ic JE 2017, SAIL 29.3.2014 B Allahabad JE-19.12.2010 Resistivity (Ω -m) 1.59 × 10 ⁻⁸ 1.68 × 10 ⁻⁸ 2.4 × 10 ⁻⁸ 2.88 × 10 ⁻⁸ 5.6 × 10 ⁻⁸ 10.6 × 10 ⁻⁸ y- minium, Platinum. contact material has cetrical conductivity. (b) low	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_{c} = H_{c(0)} \left[1 - \left(\frac{T^{2}}{T_{c}^{2}} \right) \right]$ $H_{c} = \text{critical value of magnetic field}$ $H_{c(0)} = \text{critical magnetic field at 0K}$ $T_{c} = \text{critical temperature}$ 17. is a weak electron - electron bond pair mediated by a phonon interaction. (a) Electron pair (b) Cooper pair (c) Ion pair (d) Fermions pair UPMRCL JE (S&T) 03.01.2023,1:30-3:30PM Ans. (b) : Cooper pair is a weak electron - electron bond pair mediated by a phonon interaction. Electron-phonon interaction. Electron-phonon interaction. Electron-phonon interaction. The electron-phonon interaction. Is a major scattering mechanism that limits charge carrier mobility in bulk semiconductor. 18. Pure Metals generally have: (a) High Conductivity and Low temperature
themselves due to heat that i themselves due to heat that i 1. Tin and lead less than 40°C) 2. Hard solder - melting po (a) Brass solder - Copper + 2 (b) Silver solder - Copper + 2 (c) Silver, aluminium a order of resistivity? (a) Platinum, Alumin (b) Silver, Copper, P (c) Copper, Silver, A (d) Silver, Copper, A Noida Metro Electron RRI Ans : (d) Ans : (d) Ans: (d) Aluminium Tungsten Platinum Increasing order of resistivity Silver, Copper, Alu 14. Silver tungsten (a) zero (a) zero (b) Silver Silver Copper, Alu Silver, Copper, Alu Copper, Alu Copper, Alu Silver, Copper, Alu Copper, Alu Copper, Alu Order of resistivity Silver, Copper, Alu Copper, Alu Copper, Alu Copper, Alu Copper, Alu Copper, Alu Silver, Copper, Alu Copper, Alu Copper, Alu Copper, Alu Copper, Alu Copper, Alu Copper, Alu Copper, Alu Copper, Alu Silver, Copper, Alu Copper, Al	s called solder material. soft solder (melting point int above 400°C Zinc silver wing lists four platinum, and copper in increasing hium, Copper, Silver latinum, Aluminium luminum, Platinum luminum, Platinum ic JE 2017, SAIL 29.3.2014 B Allahabad JE-19.12.2010 Resistivity (Ω -m) 1.59 × 10 ⁻⁸ 2.4 × 10 ⁻⁸ 2.88 × 10 ⁻⁸ 2.88 × 10 ⁻⁸ 5.6 × 10 ⁻⁸ 10.6 × 10 ⁻⁸ y - minium, Platinum. contact material has cetrical conductivity. (b) low (d) bigb	Superconductor is a material showing perfect conductivity and Meissner effect below a critical temperature. Effect of magnetic field on superconductivity - $H_{c} = H_{c(0)} \left[1 - \left(\frac{T^{2}}{T_{c}^{2}} \right) \right]$ $H_{c} = \text{critical value of magnetic field}$ $H_{c(0)} = \text{critical magnetic field at 0K}$ $T_{c} = \text{critical temperature}$ 17. is a weak electron - electron bond pair mediated by a phonon interaction. (a) Electron pair (b) Cooper pair (c) Ion pair (d) Fermions pair UPMRCL JE (S&T) 03.01.2023,1:30-3:30PM Ans. (b) : Cooper pair is a weak electron - electron bond pair mediated by a phonon interaction. Electron-phonon interaction. Electron-phonon interaction. Electron-phonon interaction. Electron-phonon interaction. Is a major scattering mechanism that limits charge carrier mobility in bulk semiconductor. 18. Pure Metals generally have: (a) High Conductivity and Low temperature coefficient
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A conductor material has a free-electron density 26. (c) temperature of 10²⁵ electrons per m³, When a voltage is (d) magnetic field strength applied, a constant drift velocity of 1.4×10^{-3} m/s. DFCCIL EE 17.04.2016, Shift-II If the cross-sectional area of the material is 1 Ans. (a) : The magnitude of critical density in a super cm^2 , calculate the magnitude of the current. conductor depend on both temperature and magnetic Electronic charge is 1.6×10⁻¹⁹ coulomb. field strength. The critical field generally increases to absolute zero as the temperature decreases. (b) 0.2 A (a) 0.224 A (c) 0.25 A 30. A material is said to have become superconductor (d) 0.1 A DFCCIL Executive (EE) -30.09.2021 when (a) its resistance becomes negative Ans. (a) : Given that, (b) its resistance becomes very small Free-electron density (n) = 10^{25} per m³ (c) its resistance decreases Charge on electron (e) = 1.6×10^{-19} Coulomb (d) its resistance becomes zero **RRB SSE Bilaspur Yellow paper**, 21.12.2014 Cross section area (A) = $1 \text{ cm}^2 = 1 \times 10^{-4} \text{ m}^2$ **ĴMRC JE-2013** Drift velocity (V_d) = 1.4×10^{-3} m/s Ans : (d) A material is said to have become $I = neAV_d$ superconductor when its resistance becomes zero. A $= 10^{25} \times 1.6 \times 10^{-19} \times 1 \times 10^{-4} \times 1.4 \times 10^{-3}$ superconductor is а material that attains. Superconductivity a state of matter with no electrical I = 0.224 Aresistance. In a superconductor an electric current can Which of the following lists four platinum, 24. persist indefinitely. silver, aluminium and copper in increasing For Superconducting material $(\mu_r) = 0$, Susceptibility order of resistivity? $(\chi) = \hat{N}egative,$ (a) Platinum, Aluminium, Copper, Silver The transition temperature of superconductivity 31. (b) Silver, Copper, Platinum, Aluminium (c) Copper, Silver, Aluminum, Platinum material titanium is : (a) 1.17 K (b) 14 K (d) Silver, Copper, Aluminium, Platinum (d) 0.49 K (c) 9.2 K NMRC Electronic JE 09.03.2017, SAIL 29.03.2014 UPMRCL JE 03.01.2023, 1:30 PM- 3:30 PM Ans: (d) Ans. (d): Titanium is superconducting material when Material Resistivity (Ω -m) cooled below its critical temperature of 0.49K. Silver 1.59×10^{-8} The current carrying capacity of aluminium is 32. 1.68×10^{-8} Copper what percent of the carrying capacity of copper? 2.4×10^{-8} Gold (b) 30% (a) 15% 2.88×10^{-8} Aluminium (c) 75% (d) 25% 5.6×10^{-8} UPMRCL JE 03.01.2023, 1:30 PM- 3:30 PM Tungsten Platinum 10.6×10^{-10} Ans. (c) : The percentage current carrying capacity of Aluminum is 75 % of current carrying capacity of copper. Increasing order of resistivity -Silver, Copper, Aluminium, Platinum. Current carrying capacity- Current carrying capacity of a conductor is defined as how much load a conductor 28. Superconductors now a day found their can carry. When the current flows through the application in various fields. This is due to the conductor a certain level of heat generates which can fact that they: further increases up-to the melting temperature of the (a) generate regions free from magnetic field insulation or insulating material. (b) manufacture bubble memories These factors are- • Conductor size (c) generate electrostatic field • Ambient temperature (d) generate very strong magnetic field • Installation conditions. DFCCIL EE 17.04.2016, Shift-II If a piece of metal is made to have a 33. Ans. (d) : Super conductor now a day found their temperature gradient between its two ends, an application in various field. This is due to the fact that emf is observed to exist between those ends. they generate very strong magnetic field. This effect is known as : Such substances or metal in which the value of (b) Seebeck effect (a) Thomson effect resistivity decrease very rapidly at a certain temperature (c) Peltier effect (d) Thevenin effect become zero. These substances or metal are called superconducting substances and this property is called LMRC SCTO (Electronics) 16.04.2018, Shift-II superconductivity. Ans. (a) : If a piece of metal is made to have a Superconductor generate high electromagnetic field so, temperature gradient between its two ends an emf is they are used in magnetic resonance imagining and observed to exist between those ends. This effect is nuclear magnetic resonance. known as Thomson effect. Heat observed + + + +29. The magnitude of critical density in a superconductor depends on: Heat -(a) Both temperature and magnetic field strength (b) temperature for some time and then on T,>>T, $T_1 >> T_2$ magnetic field strength

34. When a material becomes super conducting then its resistivity is	 Displacement current Diffusion current
1. Very low	(a) 1, 2 and 3 (b) 1 and 2 only
2. Zero 3. Approximate 10% of normal value	(c) 1 and 3 only (d) 2 and 3 only \mathbf{RRB} SSE (Shift-II) 01 09 2015
4. Approximate 20% of normal value	Ans : (c) The current flow in semiconductors due to
(a) 1 (b) 2	both drift current and diffusion current. The flow of
(c) 3 (d) 4 (c) + (c)	current in a semiconductors is due to both minority
KKB JE (Shift-3), 28.08. 2015, AAI 20.4.2015	The minority charge carrier depends on the temperature
becomes zero. Superconducting materials have most of	while majority carrier depends upon doping.
the free electrons and minimum resistivity.	40. In semiconductors, a donor may be-
(ii) Semiconductor & Insulators	 (a) a trivalent impurity (b) a tetravalent impurity (c) a pentavalent impurity
35. A semiconductor has generally	(d) a noble gas
valence electrons.	RRB JE (Shift-III), 16.09.2015
(a) 3 (b) 4 (c) $\frac{1}{2}$	Ans : (c) Pentavalent impurities are donor impurities.
(c) 6 (d) 2 RRB IF 31.08 2019	(Pi) Arsenic (As) etc.
LMRC JE Electronics 2016	41. Which material has the highest electrical
(RRB JE Bhopal Paper II (Shift-II), 26.08.2015)	conductivity?
(RKB JE (Snift-1), 29.08.2015), Ans (b) : A semiconductor usually has 4 valence	(a) Aluminium (b) Steel
electrons. Semiconductor are substance whose resistivity is	(c) Silver (d) Lead PDR IF 31.09 2010
between conductor and insulators, in this forbidden. The	RRB 51.00.2017 RRB Mumbai 2015, 2009
value of energy gap is about 1 eV and there are 4 electrons in the valence orbit of semiconductor	Ans. (c) : Silver has the highest electrical conductivity.
example: Silicon, Germanium.	It is a conducting material with a large number of free
36. At room temperature, the current in intrinsic	high electrical conductivity. The resistivity of silver is
semiconductor is due to-	$1.59 \times 10^{-8} \ \Omega m$ and the conductivity is $6.29 \times 10^7 \ \Omega^{-1} m^{-1}$
(a) notes (b) electrons (c) ions (d) holes and electrons both	42. In a P-type semiconductor, minority carriers are:
(d) Holes and clocately could RRB JE - 01.09.2019	(a) Holes (b) Electrons (c) Dopants (d) Atoms
RRB JE (Shift-III), 26.08.2015	(c) Dopants (d) Atoms (RRB JE (Shift-III), 26.08.2015
Ans : (d) Conduction of current in an intrinsic semiconductor at room temperature is due to both holes	LMRC JÉ Electronics,
and electrons.	Ans : (b) P-type semiconductor- When a pure
37. Which of the following is the safest ladder to be	valency impurity [such as Aluminum (Al), Boron (B)
used while working with electrical appliances?	gallium (Ga) and Indium (In)] are added, the
(c) Metal ladder (d) Fiber glass	semiconductor is become P-type semiconductor.
RRB JE 31.08.2019	carriers holes and minority charge carriers are electrons.
Ans. (d) : Fiber glass is the safest ladder to be used	43. Doping means :
while working with electrical appliance. Fiber glass is an insulating material that cannot conduct current and	(a) Addition of impurity material in
provides protection against shock and excessive current	(b) Interconnection
while working on equipment.	(c) Cleaning the surface
38. At room temperature a semiconductor	(d) Removing of impurity material in
(a) Perfect insulator (b) Superconducting	semiconductor band structure
(c) Conducting (d) Slightly conducting	RRB Chandigarn Electronic – 2014 RRB Allahabad JE-25.10.2009
RRB Mumbai 2015	Ans : (a) Doping: The process of adding impurities to a
Ans : (d) The conductivity of semiconductor is very	pure (intrinsic) semiconductor is called doping.
low at room temperature. When the temperature is increased its semiconductor conductivity increases but	• Doping leads to the formation of extrinsic
when the temperature decreases the conductivity	semiconductors which are of two types: n-type and p-type.
decreases. At 0°K the semiconductor becomes a	(a) Hole (b) Electron
dielectric. The elements of the fourth group in the periodic table are semiconductors	(c) Positive ion (d) Negative ion
39. In a semiconductor current is flow due	DFCCIL EE-11.11.2018, 12:30 PM-2:30PM
to	DFCCIL EE-17.04.2016, Shift-II RRB Jammu JE-25.10.2009
1. Drift current	RRB SSE (Shift-III), 01.09.2015

Ans : (b) Electron has greatest mobility than hole mobility. The unit of semiconductor electron mobility is $cm^2/V_{-}sec$	II. In semi-conductors the conduction and the valance bands are separated by a very narrow gap.
The mobility of electron is three times more than holes.	(a) Only II (b) Both I and II (c) Only I (d) Neither I nor II
Mobility $(\mu_e) = \frac{V_d}{E}$	DFCCIL Executive Electrical 20.12.2023, 4:30-6:30 PM
$V_d = Drift velocity$	Ans. (b) : Semiconductors are materials which have a conductivity between conductors and insulators.
E = Electric field	In semi-conductors the conduction and the valance band
μ_e = Electron mobility 45 The concentration of minority carriers in an	are separated by a very narrow gap. Energy
extrinsic semiconductor under equilibrium is :	A conduction hand
(a) Directly proportional to the intrinsic	
(b) Inversely proportional to the intrinsic	Band gap
(c) Directly proportional to the doping	Somi Conductor
concentration (d) Inversely propertional to the domina	48 allow partial current to flow through
(d) inversely proportional to the doping concentration	them. (c) Registers (b) Conductors
RRB SSE (Shift-II), 01.09.2015	(a) Resistors (b) Conductors (c) Insulators (d) Semi-conductors
Ans : (d) The concentration of minority carriers in a	DFCCIL Executive Electrical 20.12.2023, 4:30-6:30 PM
semiconductor under equilibrium will be inversely proportional to the doping concentration	Ans. (d) : Semi-conductors allow partial current to flow through them
Mass action law- In an extrinsic semiconductor at a	Semiconductors are materials which have a conductivity
constant temperature, the product of the concentration	Semiconductors can be compound, such as gallium
the square of the net concentration.	arsenide or pure elements, such as germanium or
$n.p = n_i^2$	49. Which of the following pair is correct?
For N-1ype,	I. Intrinsic semi-conductors – These are pure
Minority concentration (holes concentration) = $\frac{n_i}{N}$	semi-conductors, without any impurities added to them.
For P-type.	II. Extrinsic semi-conductors – When a small
n_i^2	amount of impurity is added to a pure semi- conductor.
Minority concentration (electron concentration) = $\frac{1}{N_A}$	(a) Both I and II (b) Only I
• This rule is used to calculate the concentration of	(c) Neither I nor II (d) Only II DECCII. Executive Electrical 20 12 2023 4:30-6:30 PM
Minority carriers at thermal equilibrium.	Ans. (a) : The semiconductor is divided into two types.
regarding insulator material porcelain ?	one is Intrinsic semiconductor and other is Extrinsic
I. It is mechanically stronger than glass.	The pure form of the semiconductor is known as the
less susceptible to temperature variations and	intrinsic semiconductor and the semiconductor in which
its surface is not affected by dirt deposits.	conductive is known of the extrinsic semiconductor.
(a) Neither I nor II (b) Both I and II (c) Only I (d) Only II	50. The operating temperature of PVC, paper, silk
DFCCIL Executive Electrical 20.12.2023, 4:30-6:30 PM	or cotton without impregnation is: (a) 105° C (b) 180° C (c) 155° C (d) 90° C
Ans. (b) : An electrical insulator is a material in which	Delhi Metro Electronic JE 2017
The most commonly used material for insulator of over	DMRC Electronics 17.02.2017, 12:00 – 2:15 PM DMRC Electronics 17.02.2017, 12:00 – 2:15 PM
The most commonly used material for insulator of over head line is porcelain.	DMRC Electronics 17.02.2017, 12:00 – 2:15 PM DMRC Electronics 17.02.2017, 8:30 to 10:45 AM Ans : (d) The operating temperature of PVC, paper.
The most commonly used material for insulator of over head line is porcelain. Porcelain is mixture of kaolin, feldspar and quartz. It is mechanically stronger than glass.	DMRC Electronics 17.02.2017, 12:00 – 2:15 PM DMRC Electronics 17.02.2017, 8:30 to 10:45 AM Ans : (d) The operating temperature of PVC, paper, silk or cotton without impregnation is 90°C.
The most commonly used material for insulator of over head line is porcelain. Porcelain is mixture of kaolin, feldspar and quartz. It is mechanically stronger than glass. It gives less trouble from leakage and is less susceptible	DMRC Electronics 17.02.2017, 12:00 – 2:15 PMDMRC Electronics 17.02.2017, 8:30 to 10:45 AMAns : (d) The operating temperature of PVC, paper, silk or cotton without impregnation is 90°C.Insulation classesMaximum permissible temperature
The most commonly used material for insulator of over head line is porcelain. Porcelain is mixture of kaolin, feldspar and quartz. It is mechanically stronger than glass. It gives less trouble from leakage and is less susceptible to temperature variation and its surface is not affected by dirt deposits	DMRC Electronics 17.02.2017, 12:00 – 2:15 PM DMRC Electronics 17.02.2017, 8:30 to 10:45 AM Ans : (d) The operating temperature of PVC, paper, silk or cotton without impregnation is 90°C. Insulation classes Maximum permissible temperature Y 90°C
The most commonly used material for insulator of over head line is porcelain. Porcelain is mixture of kaolin, feldspar and quartz. It is mechanically stronger than glass. It gives less trouble from leakage and is less susceptible to temperature variation and its surface is not affected by dirt deposits. Hence both statements are true regarding Insulator	DMRC Electronics 17.02.2017, 12:00 – 2:15 PM DMRC Electronics 17.02.2017, 8:30 to 10:45 AM Ans : (d) The operating temperature of PVC, paper, silk or cotton without impregnation is 90°C. Insulation classes Maximum permissible temperature Y 90°C A 105°C
The most commonly used material for insulator of over head line is porcelain. Porcelain is mixture of kaolin, feldspar and quartz. It is mechanically stronger than glass. It gives less trouble from leakage and is less susceptible to temperature variation and its surface is not affected by dirt deposits. Hence both statements are true regarding Insulator material porcelain.	DMRC Electronics 17.02.2017, 12:00 – 2:15 PM DMRC Electronics 17.02.2017, 8:30 to 10:45 AM Ans : (d) The operating temperature of PVC, paper, silk or cotton without impregnation is 90°C. Insulation classes Maximum permissible temperature Y 90°C A 105°C E 120°C P 120°C
 The most commonly used material for insulator of over head line is porcelain. Porcelain is mixture of kaolin, feldspar and quartz. It is mechanically stronger than glass. It gives less trouble from leakage and is less susceptible to temperature variation and its surface is not affected by dirt deposits. Hence both statements are true regarding Insulator material porcelain. 47. Which of the following statement is correct regarding semi-conductor? 	DMRC Electronics 17.02.2017, 12:00 – 2:15 PMDMRC Electronics 17.02.2017, 8:30 to 10:45 AMAns : (d) The operating temperature of PVC, paper, silk or cotton without impregnation is 90°C.Insulation classesMaximum permissible temperatureY90°CA105°CE120°CB130°CF155°C
 The most commonly used material for insulator of over head line is porcelain. Porcelain is mixture of kaolin, feldspar and quartz. It is mechanically stronger than glass. It gives less trouble from leakage and is less susceptible to temperature variation and its surface is not affected by dirt deposits. Hence both statements are true regarding Insulator material porcelain. 47. Which of the following statement is correct regarding semi-conductor? I. Semi-conductors allow partial current to 	DMRC Electronics 17.02.2017, 12:00 – 2:15 PMDMRC Electronics 17.02.2017, 8:30 to 10:45 AMAns : (d) The operating temperature of PVC, paper, silk or cotton without impregnation is 90°C.Insulation classesMaximum permissible temperatureY90°CA105°CE120°CB130°CF155°CH180°C

51. Semi-conductor materials like germanium	There are two type-
crystals with controlled doping can be used for	N-type P-Type
measurement of cryogenic temperatures especially	Dopant is a pentavalent impurity Dopant is a trivalent impurity
(a) above 100K (b) below 25K (c) below 100K (d) above 50K	Majority charge carrier are electron Majority charge carrier are holes
DFCCIL Executive Electrical 20.12.2023, 4:30-6:30 PM	Minority charge Minority charge carrier arr clostrong
crystals with controlled doping can be used for	56 Mobility and conductivity are related by which
measurement of cryogenic temperatures especially	50. Mobility and conductivity are related by which of the following equations?
below 25K.	(a) $e = nu\sigma$ (b) $\sigma = neu$
52. Which of the following materials is widely used	$(a) c nuo (b) o ne\mu (c) n = \sigma u/e (d) u = \sigma e/n$
the small, moulded parts such as lamp holder.	UPMRCL JE (S&T) 03.01.2023.1:30-3:30PM
terminal blocks and small panels?	Ans (b) · Mobility and conductivity are related by-
(a) Bakelite (b) Cotton and silk	$\sigma = neu$
(c) Polyvinyl chloride (d) Asbestos	Where.
DFCCIL Executive (EE) -30.09.2021	$\mu = Mobility of electron$
Ans. (a) : Bakelite is widely used the small, moulded	e = Charge of electron
parts such as lamp holder, terminal-blocks and small	n = Number of electron
panels. Bakelite is a polymer made up of the monomers	57. The energy gap between valence band and
phenol and formaldehyde.	conduction band in insulator is
53. For an insulating material, dielectric strength	(a) 1.5 eV (b) 5 eV
and dielectric loss should be respectively :	(c) 0.5 eV (d) 0.05 eV
(a) High and high (b) Low and high	UPMRC(SCTO) 14.04.2021
(c) High and low (d) Low and low	KKB Malda SSE-25.10.2009
RRB Mumbai C & G JE-25.10.2009	Ans. (b): The energy gap between valance band and
Ans : (c) For an insulating material dielectric strength	↑ Energy ↑ Energy
and dielectric loss should be respectively high and low.	C.B. C.B.
An electrical insulator is a material in which electric	V.B. greater than 5eV
current does not flow freely. The atoms of the insulator	Conductor
nave tignity bound electron which cannot readily move.	V.B. V.B.
54. Fermi energy level for n-type extrinsic	Semiconductor Insulator
(a) at middle of the hand gap	58. The forbidden gap of a Germanium
(a) at initial of the band gap (b) close to conduction hand	semiconductor material is $(a) = 0.12 \text{ eV}$
(c) close to valence hand	(a) 0.12 eV (b) 0.72 eV (c) 7.20 eV (d) None of these
(d) None of these	DFCCIL Executive (EE)-30.09.2021
RRB Bhonal TM SSE-25.10.2009	Ans (b) • The forbidden gap of a Germanium
Ans • (b) Fermi energy level for n-type extrinsic	semiconductor material is 0.72 eV.
semiconductors lies near to conduction band. The	59. In which of the following material's resistance
probability of occupation of energy levels by the	is independent of change in temperature?
electrons in the conduction band is greater than the	(a) Brass
probability of occupation of energy levels by the holes	(b) Platinum
in valence band. Therefore Fermi level in the n-type	(c) Tungsten
semiconductor lies close to the conduction band.	(d) Alloys of Constantan and Manganin
55is/are added in intrinsic semiconductor	RKB Chandigarh SSE-25.10.2009
for making extrinsic semiconductor.	Ans. (d): Alloy of Constantan and Manganin resistance
(a) Impurity (b) Electrons	also known as Eureka. It is allow of conner and nickel
(c) Charge carriers (d) Holes	Manganin is made of a mixture of copper manganese
UPMIRCL JE $(8\&1)$ 03.01.2023,1:30-3:30PM	and nickel. Temperature has no effect on these alloy.
Ans. (a) : Extrinsic semiconductor- The extrinsic	60. The band gap energy of Germanium at 300k
Addition of these impurities called as donants to a	is
semiconductor greatly increases the conductivity of	(a) 1.212 eV (b) 0.785eV
semiconductor, this process is called doping of	(c) 0.718 eV (d) 1.121 eV
semiconductor. Impurities (Dopants) are usually	JMRC JE-05.02.2021
either trivalent or pentavalant. Extrinsic	Ans. (c) :
semiconductor behaves as intrinsic semiconductor at	Substanceat $T = 0^{\circ} K$ at $T = 300^{\circ} K$
room temperature. its conductivity is achieved by	Germanium 0.785 eV 0.72 eV
adding impurities to the pure semiconductor.	Silicon 1.21 eV 1.12 eV

61. The conductivity of the intrinsic germanium at 300^{0} K is When, n_{i} at 300^{0} K = 2.5 × 10^{13} /cm and μ_{n} and μ_{n} in germanium are 3800	Ans. (a) : The material of wires used for making standard resistances is usually manganin. Manganin is an alloy of copper, nickel and manganese. Allov like
and 1800 cm ² /Vs respectively.	manganin and constantan are used for making standard
(a) 0.224 S/cm (b) 0.0224 S/cm	resistance coil as they have high resistivity and a low-
(c) 2.24 S/cm (d) 0.00224 S/cm	temperature co-efficient of resistance.
RRB Bhopal SSE-24.11.2002	66. Pure silicon is
Ans: (b) Conductivity of Intrinsic Germanium	(a) a p-type semiconductor (b) on n type semiconductor
$(\sigma) = (\mu_n + \mu_p)n_i e$	(c) an intrinsic semiconductor
$= (3800 + 1800) \times 2.5 \times 10^{13} \times 1.6 \times 10^{-19}$	(d) an extrinsic semiconductor
$=(5600) \times 2.5 \times 1.6 \times 10^{-6}$	LMRC (SCTO), JE - 2016, Shift-II
$= 22400 \times 10^{-6}$ Siemens/cm	RRB Patna/Allahabad SEM-III 30.01.2011
= 0.0224 S/cm	Ans : (c) The semiconductors in which no external
62. At absolute zero temperature, all the valence	impurities are added are called intrinsic semiconductor
electrons in an intrinsic semiconductor are	or purest form of semiconductor is called intrinsic semiconductor. If any foreign impurity (such as
(a) in the valence band	trivalent or pentavalent) was added to it then it is
(b) in the forbidden gap	called extrinsic semiconductor.
(c) in the conduction band	67. Which of the following defines an N-Type
(d) free electrons	semiconductor?
KKB BROPAL SSE-24.11.2002	(a) A semiconductor with excess of black hole is
Ans. (a): At absolute zero temperature valence band is	called N-type
hence there are no free electrons in the conduction band	(b) A semiconductor with excess of holes is
and holes in the valence band. At absolute zero	called N-type
temperature the charge carrier concentration is zero.	called N-type
Hence intrinsic semiconductor behaves like an	(d) A semiconductor with excess of electrons is
insulator.	called N-type.
63. Which of the following materials offers highest	JMRC JE-05.02.2021
(a) Tungsten (b) Germanium	Ans. (d) : The semiconductor in which there is excess of
(a) Fungstein (b) Germanum (c) Silicon (d) Ceramic	electrons called n-type semiconductor. In a pure
(c) Sincon BMRCL JE 24.02.2019	semiconductor, the number of electron and holes are equal.
Ans. (d) : Ceramics have highest resistivity. A ceramic	are changed by adding impurities
is a material that is neither metallic nor organic.	P-type semiconductor with trivalent impurity and n-type
Ceramics are typically hard and chemically non-reactive	semiconductor was made by adding a pentavalent impurity.
and can be formed or densified with heat. Ceramic	• There are 4 electrons in the outmost shell of a
material are used in electronic because depending on	semiconductor.
superconducting ferroelectric or an insulator	68. Which of the following options is a
Germanium and silicon are semiconductor material.	thermosetting polymer?
64. Which of the following is donor impurity	(a) PVC (b) Nylon (c) Tefler (d) Pelvelite
element?	$(c) \text{ renon} (d) \text{ bakence} $ $UPMPC \text{ IF}_{20} 01 2020 \text{ 4.00 to 6.00 PM}$
(a) Aluminium (b) Boron	RRB Bangalore SSE-01.02.2009
(c) Phosphorous (d) Indium	Ans. (d) : Bakelite is an example of a thermosetting
RRB Allanabau JE- 09.09.2012	Polymer. A thermosetting plastic is a Polymer that hard
elements added to a semiconductor in order to increase	irreversibly when heated. It is a rigid type of plastic that
the electrical conductivity of the semiconductor through	is highly resistant to heat after it has cured during the
free or unbounded electrons 5 th group element such as,	compression molding process. I hermosetting Plastic are
phosphorous, bismuth, antimony and arsenic is a donor	generally strong than thermo plastic material.
impurity.	for the manufacturing of heating element?
Acceptor impurity- Acceptor impurities are the	(a) Iron (b) Tungsten
the electrical conductivity by creating hole. It is a 2 rd	(c) Manganin (d) Nichrome
group elements (Having three valence electrons) such as	UPMRC (SCTO) 14.04.2021
aluminium, boron, gallium and indium.	RRB Chandigarh SSE 15.03.2009
65. The material of wires used for making	Ans. (d) : Nichrome is preferred for the manufacturing
standard resistances is usually:	of heating element.
(a) Manganin (b) Phosphor Bronze	Properties of heating element -
(c) Nichrome (d) Copper	ii. High resistivity
DFUCIL EE 11.11.2018, 12:30 PM-2:30 PM IMDC 1F 10.06 2017	iii. Low temperature co-efficient of resistance
JVINC JE 10.00.2017	



Composition of manganin is: Ans : (b) The temperature coefficient of intrinsic 80. (a) Copper =86%, Manganese = 12%, Nickel=2% semiconductor is negative. On increasing the (b) Copper=76%, Manganese=42%, Nickel= 24%temperature, the resistance decreases and the (c) Copper = 56%, Manganese = 42%, Nickel = 2%conductivity increases. (d) Copper = 54%, Nickel = 46%76. Which of the following is negative a LMRC JE (S&T) 12.05.2018 temperature coefficient of resistance of a **RRB** Patna Technical Engg. 27.07.2008 material. Ans: (a) Manganin alloy contain Copper, Nickel and (b) Carbon (a) Brass Manganese. Constantan is also used to make standard (d) Aluminium (c) Copper resistance in practical use. DMRC Electronics 17.02.2017, 8:30 to 10:45 AM Constantan = Copper (86%) + Mn (12%) + Ni (2%)**RRB Secunderabad Technical (Engg) 20.05.2007** Brass = Cu (67%) + Zn (33%)Ans. (b) : Carbon is a negative temperature co-efficient Eureka = Cu (60%) + Ni (40%)of resistance of a material. An intrinsic semiconductor has-81. Semiconductor material (Carbon, Silicon, Germanium) (a) An infinite resistance at 0°C usually have a negative temperature co-efficient of (b) A finite resistance, independent of resistance. temperature changes $R_t = R_0 (1 - \alpha \Delta t)$ (c) A finite resistance which decreases with R_t = Resistance of metal at t^oC temperature (d) A finite resistance which increases with R_0 = Resistance of metal at 0°C temperature α = Temperature co-efficient of resistance **RRB** Patna Technical Engg. 27.07.2008 $\Delta t = Difference$ in temperature Ans. (c) : Intrinsic semiconductor- An intrinsic semiconductor is a pure semiconductor that is free from any impurity. Pure germanium and pure silicon are examples of intrinsic semiconductor. In an intrinsic semiconductor when increasing the temperature, the value of resistance decreases and its conductivity increases. The temperature coefficient of resistance of Т intrinsic semiconductor is negative. 77. For which of the following resistance of the Materials in which large number of free 82. material increases with temperature? electrons are available in outermost orbit are (a) Semiconductors (b) Insulators called : (c) Eureka (d) Allovs (a) Semiconductors (b) Conductors LMRC SCTO (Electronics) 16.04.2018, Shift-II (c) Insulators (d) Magnetic materials **RRB Bangalore Technical (Engg.) 22.04.2007 RRB Chandigarh SSE 09.09.2012** Ans. (d) : Generally metal (Cu, $A\ell$) and alloys have DMRC Electronics 19.04.2018, 12:15 to 2:30 PM Ans. (b) : The large number of free electrons are positive temperature co-efficient as their resistance available in outermost orbit are called conductor. increases with increase in temperature. Semiconductor Example- Cu, Ag, Al etc. and insulator have negative temperature co-efficient A semiconductor when placed at 0[°] K, will act as? because resistance decrease when temperature increase. 83. (a) Insulator (b) Conductor Ex. - Alloys - Brass, Bronze, Constantan. (d) Metal Semiconductor-Silicon, Germanium, Gallium Arsenide (c) Semiconductor **RRB Chandigarh SSE 09.09.2012** Insulator - Mica, Wood, Paper, Glass. Ans. (a) : At 0°K semiconductor behaves as insulator 78. Mica is a -At 0°K valence band is completely filled while (a) Dielectric material (b) Insulating material conduction band is empty. (c) Metal (d) Both (a) & (b) There are no charge carriers available for conduction. **RRB Bangalore Technical (Engg.) 22.04.2007** 84. The transition temperature of superconductivity Ans. (d): Mica is a dielectric and insulating material. It material titanium is : has good thermal conductivity due to phonons. (a) 1.17 K (b) 14 K (c) 9.2 K (d) 0.4 K Dielectric strength of mica = 200 kV/cm**RRB Bangalore SSE 09.09.2012** Temperature = $(500 - 600)^{\circ}$ C Ans. (d) : Titanium is superconducting material when 79. Semiconductor material have: cooled below its critical temperature of 0.49K. (a) Ionic bands (b) Covalent bonds 85. A pure silicon crystal acts as a/an at (c) Mutual bonds (d) Metallic bonds room temperature. (RRB JE (Shift-III), 16.09.2015) (a) Conductor (b) Insulator **RRB Bangalore Technical (Engg.) 22.04.2007** (c) Transistor (d) Semiconductor Ans : (b) A semiconductor material such as Si, Ge, **RRB Allahabad JE 25.10.2009** these elements belong to IV Group in the periodic table. Ans. (b) : A pure silicon crystal acts as an insulators at They have 4 electron in their valence shell, In room temperature. At room temperature there is no any semiconductor sharing of electrons takes place in order free electron for conduction in silicon crystal. Hence it to get stability hence the bonding is a Covalent bond. behaves like a insulator.



94. Electron Volt and kilojoules are units to measure energy. Which option below best describes the conversion factor between the	98. The temperature coefficient of intrinsic semi conductors is-
two units? (a) $1.6 \times 10^{19} \text{ kJ}$ (b) $1.6 \times 10^{-22} \text{ kJ}$ (c) $1.6 \times 10^{22} \text{ kJ}$ (d) $1.6 \times 10^{23} \text{ kJ}$	 (b) positive (c) negative (d) same as that of metals
(c) 1.6×10^{-10} kJ (d) 1.6×10^{-10} kJ JMRC JE-05.02.2021	(d) same as that of metals
Ans. (b) :	Ans : (c) The intrinsic semiconductor has a negative
$\mathbf{E} = \frac{\mathbf{V} \times \mathbf{I} \times \mathbf{t}}{\mathbf{V} \times \mathbf{I} \times \mathbf{t}}$	increase in temperature.
1000	Example - Si, Ĝe
$E = \frac{V \times Q}{1000}$	99. Temperature coefficient of resistance of an extrinsic semiconductor is
$1 \times 1.6 \times 10^{-19}$	(a) Zero
$E = \frac{1}{1000}$	(b) Positive (c) Negative
$E = 1.6 \times 10^{-22} \text{ kJ}$	(d) Dependent on size of specimen
95. which of the following is a semiconductor?	DMRC Electronics - 2014
(a) Ceramic (b) Silicon	Ans. (b) : When a tri or pentavalent impurity is added
(c) Iron (d) Copper $\mathbf{DMPC} = 23.02, 2020$ (Shift I)	to a pure semiconductor material. It becomes an extrinsic semiconductor material and on increasing its
DMRC - 25.02.2020, (Smit-1) DMRC (Regular)-2020	temperature, conductivity decreases and resistivity
Ans. (b) : Semiconductor- Semiconductor are those	increases. Therefore the temperature coefficient of
substances which have resistivity occurs between	resistance of an extrinsic semiconductor is positive. $\mathbf{P} = \mathbf{P} \cdot (1 + \mathbf{r} + \mathbf{t})$
(Ge), silicon (Si), Selenium (Se) etc.	$R_{t} = R_{0} (1 + \alpha \Delta t)$
• Ceramic belongs to insulators.	$\frac{\mathbf{R}_{t} = \mathbf{R}_{0} + \mathbf{R}_{0}}{\mathbf{\Delta t}}$
• Iron and copper come under the conductor.	$\alpha = \frac{R_t - R_0}{R_t}$
96. In a P-type semiconductor, Fermi-level is close	$\mathbf{R}_{0}\Delta t$
(a) The bottom of the valence band	$\overline{R_t} = Resistance at t^{\circ}C$
(b) The top of the valence band	$R_0 = Resistance at 0^{\circ}C$
(c) The top of the conduction band	$\Delta t = 1$ emperature difference
(d) The bottom of the conduction band (RRB SSE Secunderabad (Shift-I), 02.09.2015)	100 Pure silicon is
Ans : (b) Fermi level is the energy level of a substance	(a) a p-type semiconductor
in which the probability of filling the valence band by	(b) an n-type semiconductor
an electron is 50%. In pure semiconductors, the Fermi surface energy lies in the middle of the gap (between	(c) an intrinsic semiconductor (d) an extrinsic semiconductor
valence and conduction bands) N-type semiconductor	(d) an extrinsic semiconductor LMRC (SCTO), JE - 2016, Shift-II
lies below the conduction band whereas P-type	Ans : (c) The semiconductors in which no external
semiconductor it lies above the valence band.	impurities are added are called intrinsic semiconductor
E,	or purest form of semiconductor is called intrinsic semiconductor. If any foreign impurity (such as
Eg = 1.12eV	trivalent or pentavalent) was added to it. then it, is
E _A 0.080 eV	called extrinsic semiconductor.
E _v 1	101. When donor type impurity is added to semi- conductor material
97. The following property of semiconductors	(a) electrons are generated and material is N-
cannot be determined from Hall effect:	(b) abortrong are generated and material is D
(a) Semiconductor is n-type or p-type (b) The corrier concentration	(b) elections are generated and material is P-
(c) The mobility of semiconductor	(c) holes are generated and material is called P-
(d) The atomic concentration of semiconductor	type
DMRC Electronics - 2016	(d) holes are generated and material is called N-
Ans. (d) : The atomic concentration of semiconductor can not be determined by hall effect. While the type of	RRB SSE Bilaspur Yellow paper, 21.12.2014
semiconductors (P type or N-type) can be determined	Ans : (a) The N-type impurity loses its extra valence
by hall effect and the carrier concentration and mobility	electron easily when added to a semiconductor material.
of the semiconductor can also be determined. The	 This impurity increases the conductivity of the material by contributing a free electron
effect. whether the substance is metal, semiconductor or	• This type of impurity has 5 valence electron and is
an insulator.	called a pentavalent impurity.
Electronic Component and Materials	22 YCT



112. The room temperature resistivity (in ohm- meter) of pure silicon is:	Ans : (c) P-type and N-type semiconductor are electrically neutral.
(a) 3000 (b) 300 (c) 30 (d) 3	P-type semiconductor- A p-type semiconductor is
LMRC JE Electronics 2016	formed by adding a third group element such as Al, B,
Ans : (a) Resistivity of pure silicon at room	Ga, In. As a doping element an impurity added creates a
temperature is 3000 ohm-meter. The resistivity of a	vacancy of electrons. The impurity atom is surrounded
material is equal to the resistance of that material	by four silicon atom.
having unit length and cut should also be a unit square.	• The semiconductor having holes as majority charge
113. Free electrons exist in :	carriers and electrons as a minority charge carrier is
(a) Free band (b) Second band	called a n-type semiconductor
(c) Conduction band (d) Does not exist	• They are neutral
LMRC SC/TO Shift-2, J.E. 2016	
Ans : (c) Conduction band: The region in which free	118. Forbidden energy gap in Silicon is:
electrons remain is called the conduction band. In the	(a) 1.1 eV (b) 2.4 eV
case of conductors like metals, the valence band and	(c) 0.72 eV (d) 0.97 eV
conduction band overlap each other and almost all the	LMRC SC/TO Shift-2 2016
charge carriers are found in the conduction band. This is	Ans : (a) The Forbidden energy gap (ΔE_g) for silicon is
the reason they are good conductors of electricity.	1.1eV.
114. Resistivity of a semiconductor by adding	The energy gap between the conduction band and
impurities	valence band is known as the forbidden energy gap i.e.
(a) Increases	$\Delta E_{g} = (C.B)_{min} - (V.B)_{max}$
(h) Decreases	
(c) First decrease then increase	CB
(d) First increase then decrease	1 AE
RRB Allahahad Electronic (Paner-II)- 2014	
Ans \cdot (b) When an impurity is added to a	V.B
semiconductor then its resistivity decreases and its	
conductivity increases	119. N-type semiconductors are formed by adding:
115 Which of the following trivalent element	(a) Divalent impurities to pure semiconductor
(a) Boron (b) Indium	(b) Trivalent impurities to pure semiconductor
$(a) \text{Doron} \qquad (b) \text{Indum} \\ (a) \text{Aluminium} \qquad (d) \text{All}$	(c) Tetravalent impurities to pure semiconductor
$\begin{array}{c} \textbf{(c)} \text{Aluminium} \\ \textbf{RBR Guwabati Flectronic} = 2014 \end{array}$	(d) Pentavalent impurities to pure
RRB Allahabad Electronic (Paper-II) – 2014	semiconductor
Ans : (d) Trivalent element	LMRC SC/TO Shift-2 J.E. 2016
1 Boron (5)= $2 - 3$	Ans: (d) An N-type semiconductor is formed when a
2. Indium(49)= 2. 8. 18 18.3	small amount of pentavalent impurity is added to a pure
3. Aluminium $(13)=2$, 8, 3	germanium or silicon crystal. The addition of
All element are trivalent element.	pentavalent impurity produces a large no. of free
116 In an intrinsic semiconductor the fermi level is	electrons in the host crystal. To explain the formation of
(a) Closer to valence band	N-type semiconductor let us introduce a pentavalent
(b) Closer to conduction hand	impurity atom into the lattice of pure silicon.
(c) Within the balance band	120. The energy of a photon of light whose
(d) Midway between the valence and conduction	wavelength is 620 nm equals the band gap of a
bands.	semi conducting material. What is the
UPMRC (SCTO) - 14.04.2021	minimum energy required to create a hole cloatron pair?
Ans : (d) The Fermi level in an intrinsic semiconductor	(a) 2 a V (b) 0.72 a V
is nearly midway between the conduction and valence	(a) $2 eV$ (b) $0.72 eV$
band.	(0) 0.125 ev $(0) 0.5 ev$
Fermi level is the highest energy state occupied by	LWRC SC/TO SIIII-2 J.E. 2010
electrons in a material at absolute zero temperature is	Ans: (a) Given that,
known as the Fermi level.	$\lambda = 620 \text{ nm} = 620 \times 10 \text{ m} = 0.620 \times 10 \text{ m}$
CB	$= 0.620 \mu m$
Fermi level	п 1.24 1.24
E	$E_g = \frac{1}{\lambda (\mu m)} = \frac{1}{0.620 \mu m} = 2eV$
VB gap.	
117 Which of the following is a connect statement	121. It a small amount of phosphorous is added to
about P-type semiconductors?	germanium, tnen:
(a) They are negatively charged	(a) The conductivity decreases (b) Silicon because a D target state
(h) They are nositively charged	(b) Sincon becomes a P-type semiconductor
(c) They are positively enarged	(c) Phosphorous becomes an acceptor impurity
(d) Some are positive while some are negative	(a) There will be more free electrons than holes
LMRC SC/TO Shift-2 J.E. 2016	In semiconductor LMRC SC/TO Shift-2, J.E. 2016

Ans : (d) If a small amount of phosphorous is added to	126. The mean free path for electron drift
germanium, then There will be more free electrons than	with purity.
holes in semiconductor.	(a) Increases
The elements whose atom have five valence electrons	(b) Decreases
are called pentavalent impurities e.g. Phosphorus (P),	(c) First increases then decreases
Arsenic (As), Antimony (Sb), Bismuth (Bi) etc.	(d) Remain same
• These impurities are also called donor impurities	RRB SSE (Shift-III), 01.09.2015
because they donate an extra free electron.	Ans : (a) Mean free nath is defined as the average
• Thus, the n-type semiconductor is obtained if we	distance an electron travels between two successive
doped phosphorus with germanium.	collisions
122. Which of the following will serve as a donor	• As the impurity increases an electron suffers more
impurity in silicon?	collision because of impurity atoms
(a) Boron (b) Indium	• The mean free noth for electron drift increases with
(c) Germanium (d) Antimony	• The mean nee pair for election drift increases with purity
LWRC SCIO Shift-I-2016	
Ans: (d) when a pentavalent impurity is added to an intrinsic or pure comission ductor (Silicon or companium)	127. On what avalanche breakdown depends
then it is said to be an n type semiconductor	(a) Doping (b) Collision
 Dentevalant impurities such as Desenhorus (D) Argonia 	(c) Ionization (d) Recombination
• rentavalent impultues such as rhospholus (r), Alsenic (As) Antimony(Sh) etc are called donor impurities	RRB JE Secundrabad (Shift-I), 18.08.2015
123 In on a type comised doilor imputates.	Ans : (b) Avalanche breakdown:-
123. III all II-type scillconductor, as the donor concentration N _n increases the Fermi level F	Avalanche breakdown is a phenomenon that can occur
(a) Remains unaltered	in both insulating and semiconducting material. It is a
(b) Moves towards the conduction hand	form of electric current multiplication that can allow
(c) Move towards the center of forbidden energy	very large currents within materials which are otherwise
gan	good insulators. It is a type of electron avalanche. The
(d) May or may not move depending on	avalanche process occurs when carriers in the transition
temperature	region are accelerated by electric field to energies
DMRC Electronic, 2016	sufficient to create mobile or free electron-hole pairs via
Ans.: (b) In an N-type of semiconductor, as the donor	collisions with bound electrons.
concentration N _D increases, the fermi level E _f moves	128. Merging of a free electron and a hole is called :
towards the conduction band or the Fermi level moves	(a) Recombination (b) Neutralization
away from the center of energy gap and the	(c) Restriking (d) Zeroing
away from the center of energy gap and the conductivity increases.	(c) Restriking (d) Zeroing LMRC SC/TO Shift-2 J.E. 2016
away from the center of energy gap and the conductivity increases. 124. The intrinsic carrier concentration of silicon	(c) Restriking (d) Zeroing LMRC SC/TO Shift-2 J.E. 2016 Ans : (a) Merging of a free electron and a hole is called
away from the center of energy gap and the conductivity increases. 124. The intrinsic carrier concentration of silicon sample at 300K is 2.5×10^{16} /m ³ . If after	 (c) Restriking (d) Zeroing LMRC SC/TO Shift-2 J.E. 2016 Ans : (a) Merging of a free electron and a hole is called Recombination. Semiconductors are characterized by
 away from the center of energy gap and the conductivity increases. 124. The intrinsic carrier concentration of silicon sample at 300K is 2.5 × 10¹⁶/m³. If after doping, the number of majority carriers is 5 × 10¹⁰/m³. 	 (c) Restriking (d) Zeroing LMRC SC/TO Shift-2 J.E. 2016 Ans : (a) Merging of a free electron and a hole is called Recombination. Semiconductors are characterized by two types of mobile carriers electrons in the conduction
away from the center of energy gap and the conductivity increases. 124. The intrinsic carrier concentration of silicon sample at 300K is 2.5×10^{16} /m ³ . If after doping, the number of majority carriers is 5×10^{20} /m ³ , the minority carrier density is-	 (c) Restriking (d) Zeroing LMRC SC/TO Shift-2 J.E. 2016 Ans : (a) Merging of a free electron and a hole is called Recombination. Semiconductors are characterized by two types of mobile carriers electrons in the conduction band and holes in the valence band. Both bands are
away from the center of energy gap and the conductivity increases. 124. The intrinsic carrier concentration of silicon sample at 300K is 2.5×10^{16} /m ³ . If after doping, the number of majority carriers is 5×10^{20} /m ³ , the minority carrier density is- (a) 1.25×10^{12} /m ³ (b) 0.125×10^{12} /m ³	 (c) Restriking (d) Zeroing LMRC SC/TO Shift-2 J.E. 2016 Ans : (a) Merging of a free electron and a hole is called Recombination. Semiconductors are characterized by two types of mobile carriers electrons in the conduction band and holes in the valence band. Both bands are separated by a energy gap. When an electron loses energy
away from the center of energy gap and the conductivity increases. 124. The intrinsic carrier concentration of silicon sample at 300K is 2.5×10^{16} /m ³ . If after doping, the number of majority carriers is 5×10^{20} /m ³ , the minority carrier density is– (a) 1.25×10^{12} /m ³ (b) 0.125×10^{12} /m ³ (c) 2.5×10^{20} /m ³ (d) 0.5×10^{4} /m ³	 (c) Restriking (d) Zeroing LMRC SC/TO Shift-2 J.E. 2016 Ans : (a) Merging of a free electron and a hole is called Recombination. Semiconductors are characterized by two types of mobile carriers electrons in the conduction band and holes in the valence band. Both bands are separated by a energy gap. When an electron loses energy and falls into the valance band, it gets neutralized by a hole
away from the center of energy gap and the conductivity increases. 124. The intrinsic carrier concentration of silicon sample at 300K is 2.5×10^{16} /m ³ . If after doping, the number of majority carriers is 5×10^{20} /m ³ , the minority carrier density is– (a) 1.25×10^{12} /m ³ (b) 0.125×10^{12} /m ³ (c) 2.5×10^{20} /m ³ (d) 0.5×10^{4} /m ³ DMRC Electronic, 2014	 (c) Restriking (d) Zeroing LMRC SC/TO Shift-2 J.E. 2016 Ans: (a) Merging of a free electron and a hole is called Recombination. Semiconductors are characterized by two types of mobile carriers electrons in the conduction band and holes in the valence band. Both bands are separated by a energy gap. When an electron loses energy and falls into the valance band, it gets neutralized by a hole that absorbs its energy. This process is called
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153. The correct sequence of increasing order of 157. Varnishes protect the insulating materials against electrical resistivity of the given materials is -(a) dust and oil (a) Diamond, doped germanium, silicon, gold (b) moisture, dirt and oil (b) Gold, silicon, doped germanium, diamond (c) moisture and fire hazards (c) Gold, doped germanium, silicon, diamond (d) None of the above (d) Gold, diamond, silicon, doped germanium **RRB Chandigarh SSE-26.02.2012** LMRC SCTO Shift-I-2016 Ans : (b) Varnishes protect the insulating materials Ans : (c) against moisture, dirt and oil. **Properties of Good Varnish -**Material Resistivity (Ω -m) (i) It should be soft. Silver 1.59×10^{-6} (ii) It should be dry quickly. Copper 1.68×10^{-1} (iii) Is should not shrink or crack after drying. 2.4×10^{-8} Gold 158. Which one of the following material is not a Aluminium 2.88×10^{-8} **Piezoelectric Material?** 5.6×10^{-8} Tungsten (a) BaTiO₃ (b) Ouartz 10.6×10^{-10} Platinum (c) Rochelle Salt (d) Yttrium garnet 48.2×10^{-1} **RRB Allahabad SSE19.12.2010** Manganin 98×10^{-1} Ans : (d) When a varying potential applied to the Mercury proper axis of a crystal there is a change in dimension Nichrome 100×10^{-8} of the crystal. It is known as Piezo-electric effect. Germanium $1 - 500 \times 10^{-3}$ Ex. - BaTiO₃, Quartz, Rochelle salt. Silicon 0.1 - 60 When an intrinsic silicon crystal gains 159. Diamond 1.0×10^{11} - 1.0×10^{18} sufficient heat (thermal energy) then: Increasing order of electrical resistivity -(a) some valence electrons join their covalent bonds to jump the gap into conduction band. Gold, doped germanium, silicon, diamond. Valence electrons drop out for stability. 154. Susceptibility for Paramagnetic materials is : (b)(c) some valence electrons break covalent bonds (a) Positive and small to jump the gap into conduction band. (b) Negative and small all valence electrons break their covalent (d) (c) Positive and large bonds. (d) Negative and large **RRB** Allahabad SSE-19.12.2010 LMRC JE Electronics 2016 Ans : (c) When an internal silicon crystal receives Ans : (a) Paramagnetic material have very small sufficient heat (thermal energy) the valence electrons susceptibility and have positive susceptibility. In break the covalent bond to escape from the conduction paramagnetic material net atomic dipole moment of an band gap. atom is not zero. The atom of paramagnetic substances Silicon removes and replaces an atom of a semi have permanent dipole moment due to unpaired Spin. conductor with five valencies in the crystal. Relative permeability is slightly greater than 1. If temperature of a pure silicon specimen is 160. Ex.- Al, Na, Pt, Mn increased. then Which of the following is NOT an example of a 155. (a) Only number of free electrons increase. semiconductor material? (b) Only number of free holes increase. (a) Silicon (b) Copper Number of free holes and free electrons (c) (c) Germanium (d) Arsenic increases. DFCCIL EE 11.11.2018, 12:30 PM-2:30 PM (d) Only number of free holes decrease. Ans. (b) : Copper is not an example of a semiconductor **RRB Mumbai JE 05.10.2008** material. Silicon, germanium and arsenic are example of Ans : (c) If temperature of a pure silicon specimen is semiconductor material and copper is a conductor material. increased, then number of holes and free electrons 156. The temperature coefficient of resistance of an increases because holes and electrons are connected insulator is : with co-valent bond, when the temperature increases (a) Positive and independent of temperature co-valent bond breaks and co-valent bond looses holes (b) Negative and independent of temperature and electrons. (c) Negative and dependent on temperature 161. Which of the following are used in making (d) Positive and dependent on temperature resistance temperature detectors? LMRC JE Electronics 2016 (a) Nickel (b) Tungsten RRB Patna/Allahabad ESM-III, 30.01.2011 (c) Copper (d) All these Ans : (c) The temperature co-efficient of resistance of **RRB Mumbai SSE-05.10.2008** an insulator is negative and dependent on temperature. **Ans.** (d) : When temperature changes the resistance of the conductor also changes. It is used to measure Resistance (Ω) temperature. Platinum, Nickel, Copper are used in making resistance temperature detector. Resistance temperature detector also known as RTD sensors. It is similar to thermistor. Both RTD and thermistor have

Temperature (K)

different temperature dependence.





177. Principle of Hall Effect is used in the	(c) are neutral
construction of which one of the following?	(d) None of these
(a) Ammeter (b) Voltmeter	RRB Bhopal TM SSE-25.10.2009
(c) Galvanometer (d) Gauss meter	Ans : (a) The donor atom in an n-type semiconductor at
KRB Jammu JE-25.10.2009	normal temperature is carry a positive charge.
Ans. (d) : Principle of Hall effect is used in the	182. Which among the following is termed as the drift velocity of the charge carrier per unit
Hall's effect is used to measure carrier concentration	electric field?
Some other applications of Hall's effect-	(a) Resistivity (b) Current density
• Measurement of mobility.	(c) Mobility (d) Relative permittivity
• Measurement of magnetic flux density.	RRB Allahabad SSE-09.09.2012
• Measurement of displacement.	Ans : (c) Mobility is formally defined as the value of
• Measurement of power in EM waves.	the drift velocity per-unit of electric field strength.
Conductivity of semiconductor	Thus, the faster the particle moves at a given electric
Resistivity of semiconductor	field strength, the larger the mobility.
• It can also be used to determine whether the given	$V_d = \mu E$
material is n-type, p-type, intrinsic or metal.	Where,
178. What is the resultant charge in a body	V_d = Drift Velocity
whenever the number of protons equal the	$\mu = Mobility$
number of electrons in it?	E= Electric-field.
(a) positive energe (b) sometimes positive and sometimes negative	183. A hole is the vacancy created when
(c) zero charge	(a) a free electron moves on application of
(d) negative charge	electric field
RRB Malda SSE 25.10.2009	(b) an electron breaks its covalent band
Ans (c) : When an atom has an equal number of	(c) an atomic core moves (d) an algorithm reports from conduction hand to
electrons and protons, it has an equal number of	(d) an election revents from conduction band to valence band
negative electric charges (the electrons) and positive	RRB Bangalore SSE-09 09 2012
electric charges (the protons). The total electric charge	Ans: (b) An electron is dislodged from covalent bond to
of the atom is zero and the atom is said to be neutral.	create hole.
179. Pentavalent impurities:	Si
(a) Have three valency electrons (b) Introduce holes when added to a	(+4) • Hole
semiconductor material	• Election
(c) Are introduced by adding aluminium atoms to	s Armon and s
a semiconductor material	SI (4)
(d) Increase the conduction of a semiconductor	
material DDD Malda SSE 25 10 2000	(+4)
KKD Malua SSE-25.10.2009	Si
Ans. (a) : Pentavalent impunities increase the conduction of a semiconductor material Pentavalent	When an electrons breakes a covalent bond and moves
impurities are the atom with five valance electrons used	away a vacancy is created in the broken covalent bond.
for the doping of semiconductor i.e. Arsenic (As),	I his vacancy is called note. Free electron and note are
Phosphorous (P) Antimony (Sb) etc.	always generated in pairs.
180. With increase in temperature, the resistance of	in new
semiconductors :	(a) wide energy band
(a) Increases (b) Decreases	(b) narrow energy band
(c) Do not change	(c) discrete energy level just below conduction
(d) May increases of decreases	level
(d) May mercases of decreases RRB Allahabad JE-25.10.2009	(d) discrete energy level just above valence level
Ans : (b) When the temperature increased in the	RRB Kolkata SSE-09.09.2012
semiconductor, the forbidden gap between the two bands	Ans : (c) Donor impurity atom in a semiconductor
becomes very less and the electrons move from the	results in new discrete energy level just below
valance band to the conduction band. When the	conduction band.
temperature is increased in a semiconductor, the density	185. A n-type semiconductor is:
of the charge carriers also increases and the resistivity	(a) positively charged (b) negatively charged
191 The dependence in an N terre and in the	(c) electrically neutral
101. The uonor atoms in an IN-type semi-conductor	(d) not used in semiconductor devices
(a) carry a positive charge	RRB Kolkata SSE-09.09.2012
(b) carry a negative charge	Ans: (c) n-type semiconductor is electrically neutral.

186. In a semiconductor, movement of charge carriers under influence of an electric field is called	 (c) make semiconductors less than 100 percent pure (d) alter the crystal structures of pure
(a) diffusion (b) drift	semiconductors
(c) mobility (d) conductivity	RRB Bangalore SSE 01.02.2009
Ans : (b) In a semiconductor, movement of charge carriers under influence of an electric field is called drift. When we apply potential-difference across two ends of a conductor the electric field. The average velocity at which	Ans : (d) Doping materials are called impurities because they alter the crystal structures of pure semiconductors. Semiconductor materials are doped to make them practically useful. These impurities can be trivalent or pentavalent.
these electrons drift inside the conductor on application of	191. The band gap energy (E_g) is the minimum energy required to break a covalent bond and
electric field is called drift velocity.	thus, generates :
187. The pair of acceptor impurities for	(a) bound charge only
(a) Gallium and Indium	(b) an electron – noie pair (c) electrons only
(b) Arsenic and Argon	(d) holes only
(c) Arsenic and Antimony	RRB Chandigarh SSE 15.03.2009
(d) Gallium and Helium PDR Jammy SSE 00 00 2012	Ans. (b) : The minimum energy required to break a
DMRC JE 2018. Shift-J	1 leV for silicon (Si) At higher temperature the
Ans. (a) : The trivalent impurity is added to an intrinsic	number of electrons passing over to the conduction
or pure semiconductor, then it said to be a p-type semiconductor.	band is higher, leaving equal no. of holes in the valence band.
Aluminium etc. are called acceptor impurities	192. The fermi level E_F in an intrinsic semiconductor if effective masses of holes and
188. When a free electron is recaptured by a hole.	electrons are same, is :
the process is called:	(a) $E_{C} - E_{V}$ (b) $E_{C} + E_{V}$
(a) recombination (b) diffusion	(c) $\frac{E_{C} + E_{V}}{E_{C} - E_{V}}$ (d) $\frac{E_{C} - E_{V}}{E_{C} - E_{V}}$
(c) drift (d) restoration BRB Allababad IF-09 09 2012	(c) 2 (d) 2
Ans : (a) When a free electron is recaptured by a hole	RRB Chennai SSE 12.02.2012
the process is called recombination. Recombination of	having probability 1/2 of being occupied of an electron
electron and holes is a process by which both carriers	if there is no forbidden band exist.
steps the empty state associated with a hole. Both	Fermi level in intrinsic semiconductor
carriers eventually disappear in the process.	$\mathbf{E}_{\rm r} = \frac{\mathbf{E}_{\rm c} + \mathbf{E}_{\rm v}}{\mathbf{E}_{\rm r}} - \frac{\mathbf{K}\mathbf{T}}{\mathbf{K}} / \mathbf{n} \frac{\mathbf{N}_{\rm c}}{\mathbf{N}_{\rm c}}$
189. At room temperature intrinsic carrier	$2_{\rm F}$ 2 2 $N_{\rm V}$
concentration is higher in germanium than in	$E_{\rm C}$ = Maximum energy of conduction band
(a) carrier mobilities are higher Ge than in Si	$E_V = Maximum$ energy of valence band If $N_{i} \approx N_{i}$ then form level lies in the middle of
(b) energy gap in Ge is smaller than in Si	$N_V \equiv N_C$ then form level lies in the initiate of energy gap
(c) atomic number of Ge is larger than in Si	F + F
(d) atomic weight of Ge is larger than in Si	$E_{\rm F} = \frac{E_{\rm C} + E_{\rm V}}{2}$
Ans : (b) At room temperature intrinsic carrier	At 0 K fermi level lies in the middle of energy gap.
concentration is higher in germanium compare to	Fermi level in pure semiconductor depends on
silicon because energy gap in Ge is smaller than Si.	temperatures.
For Si For Ge	195. In an intrinsic semiconductor Fermi Level represents the energy, with probability of its
Conduction band Conduction band	occupation of
+	(a) 0% (b) 25%
E Band $gan = 1.1 eV$ E Band $gan = 0.72 eV$	(c) 50% (d) 100%
	Ans (c) · Fermi energy is determined as the energy
Valanaa hand	point where the probability of occupation of an
valence band valence band	electrons is exactly 50% or 0.5 i.e. ¹ for the intrinsic
190. Doping materials are called impurities because	electrons is exactly 30% of 0.5 i.e. $\frac{1}{2}$ for the intrinsic
they:	
	semi conductor, since electrons and holes are always
(a) decrease the number of charge carriers	semi conductor, since electrons and holes are always created in pairs, $n = p = n_i$. Hence there are equal number of hole and electrons in

194. A reverse biased PN j (a) amplifier	unction will act as a/an: (b) open switch	Corrosion or rusting can be prevented by– (i) Electroplating process
(c) attenuator	(d) closed switch	(ii) Painting the surface of the metal
DN	IRC JE 2019, 2018, Shift-I	(iii) Oiling the surface of the metal
Ans (b) · Since a reverse b	iased n-n junction does not	199. Permanent magnets used in instruments are generally made of .
conduct current means no ar	iv current flow through the	(a) Stainless steel (b) Alnico
junction and it has high resi	stance across the junction.	(c) λ -alloy (d) Cast iron
Therefore a reverse biased j	p-n junction will act as an	RRB JE 31.08.2019
195 Basic composition of	Mica is given by:	RRB Mumbai C & G JE 25.10.2009
(a) $H_2Al_3(SiO_4)_3$	(b) $KH_2Al_3(SiO_4)_3$	Ans : (b) Permanent magnet used in instrument are generally made of Alnico. Alnico is a magnetic alloy of
(c) $KH_2Al_3O_4$	(d) $KH_2(SiO_4)_3$	aluminium, cobalt and nickel.
LMRC SCTO (Elect	ronics) 16.04.2018, Shift-II	200. Which element has 10 electrons?
Ans. (b):	onia KH Al (SiO)	(a) Na (b) Ne
(i) Mica is a complex silicat	te compound	(c) Ar (d) He RRB IE 31 08 2019
(iii) Alkaline substance lik	te potassium, silica and	Ans (b): Where Ionic structure $= 1S^2 + 2S^2 + 2D^6$
alumina are also found in	n it.	Ne has 10 electron Na has 11 electron Ar has 18
(iv) Mica is conductor of electricity Due to its hi	t heat and insulator of ah thermal resistance mical	electron. He has 2 electron.
is used as an insulator in	various electronic devices.	201. The property of material by which it can be
196. For temperature g	greater than 180°C in	rolled into sheets is called–
insulating materials, (the insulation class is:	(a) Flasherty (b) Maneability (c) Ductility (d) Elasticity
(a) Class C insulation (c) Class E insulation	(d) Class A insulation (d) Class B insulation	RRB JE- 01.09.2019
LMRC SCTO (Elect	ronics) 16.04.2018, Shift-II	Ans. (b) : The property of material by which it can be
Ans. (a) : Class C insulatio	n material has temperature	rolled into sheets is called malleability. A material is
greater than 180°C.		made by inting, pressing and rotating it. Mancable metal are gold and silver, which can be molded into any
Insulation Class	Maximum	shape by these processes.
Y	90°C	202. Soft iron is used in the manufacture of
A	105°C	because of its
E	120°C	(b) low retentivity only
В	130°C	(c) low coercive field only
F	155°C	(d) high saturation magnetization, low retentivity
H C	180°C	RRB SSE Bilasnur Vellow naner, 21.12.2014
197. Which of the fo	llowing ontions is a	Ans : (d) Soft iron is used in the manufacture of
thermosetting polyme	er?	electromagnets because of its high saturation
(a) PVC	(b) Nylon	magnetization, low retentivity and low coercive field.
(c) Teflon	(d) Bakelite $(1, 2, 2, 2, 3, 2, 3, 2, 3, 2, 3, 3, 3, 3, 3, 3, 3, 3, 3, 3, 3, 3, 3,$	direction of magnetization can be easily change by the
$\frac{\text{UPMRC JE-2}}{\text{Ans}}$	$\begin{array}{c} \textbf{0.01.2020, 4:00 to 0:00 PM} \\ \textbf{xample of a thermosetting} \end{array}$	applied magnetic field.
Polymer. A thermosetting pla	astic is a Polymer that hard	B
irreversibly when heated. It i	s a rigid type of plastic that	Retentivity
is highly resistant to heat at	ter it has cured during the	$-H \leftarrow \frac{A}{PO} \xrightarrow{B} H$
generally strong than thermo	plastic material.	C
		Coercivity
(iii) Magnetic M	aterials	-B Use of soft iron -
198. Corrosion or rusting	can be prevented by-	(i) In armature core
(a) Electroplating pro	cess	(ii) In measuring instrument.
(b) All of the options	· · · · C · I · · · · · · · · ·	203. A permanent magnet will not attract
(c) Painting the surface	of the metal	(a) Sieei (b) INICKEI (c) Aluminium (d) Conner
(u) Onling the surface	RRB JE 31.08.2019	RRB JE Mumbai 05.10.2008
	JMRC JE 10.06.2017	Ans : (d) A permanent magnet will not attract copper
Ans. (b) : Corrosion or Rus	ting occur, when a refined	because copper is a diamagnetic material. Permanent
oxide hydroxide or sulphide	state.	property once they are magnetised.

 (a) First pair is a version of the concentration of the concentration of the concentration of the adverse of an external magnetic field. Ans. (b) : Ferromagnetic materials which exhibit a spontaneous net magnetization at the atomic level, even in the absence of an external magnetic field. Example: Iron, Cobalt, Nickel etc. Ans. (b) : The materials having low retentivity are suitable for making low retentivity are suitable for making low retentivity are suitable for making temporary magnets. Ans. (a) : The materials having low retentivity are suitable for making temporary magnets. Ans. (a) : The materials having low retentivity are suitable for making temporary magnets. Ans. (a) : The materials having low retentivity are suitable for making temporary magnets. Ans. (b) : Modrately changes (c) Shows improvement (d) Remains unaffected (d) Remains unaffected (e) Shows improvement (f) Remains unaffected (f) Remains unaffected (f) Remains unaffected (g) Perishes (h) Modrately changes (c) Shows improvement (d) Remains unaffected (f) Hard magnetic materials (g) Retromagnetic material perishes. Above curie temperature the magnetic material become arramagnetic material perishes. Above curie temperature the magnetic material become arramagnetic material perishes. Above curie temperature the magnetic material become arramagnetic material perishes. Above curie temperature the magnetic material become arramagnetic material perishes. Above curie temperature the magnetic material become arramagnetic material perishes. Above curie temperature the magnetic material become arramagnetic material perishes. Above curie temperature the magnetic material become arramagnetic material perishes. Above the curie temperature the magnetic material become arramagnetic material perishes. Above the curie temperature the magnetic	Property of permanent magnet - (i) High coercivity (ii) High permeability	208. <u>is a weak electron - electron bound pair</u> mediated by a phonon interaction. (a) Electron pair (b) Cooper pair
 (a) Very small and positive (b) Very large and positive 	(ii) High retentivity	(a) Election pair (b) Cooper pair (c) Ion pair (d) Fermions pair
 (a) Very small and positive (b) Very small and positive (c) Very small and negative (d) Very small an degative (e) Very small and negative (f) Very small and negative (g) Very small and negative (h) Second pair is a weak electron - lectron bound pair Ans. (b) : Cooper pair is a weak electron - lectron bound pair (f) Very small and negative (g) Very small and negative (h) Second pair (h) Second pair Ans. (b) : Cooper pair is a weak electron - lectron - bound pair (h) Second pair	20.4 In a farromagnetic material suscentibility is	UPMRCL_JE 03.01.2023. 1:30 PM- 3:30 PM
 (b) Very large and positive (c) Very small and negative (d) Very large and negative (e) Very small and negative (f) Very large and negative (g) Very large and negative (h) Second pair Electron-phonon interaction - The electron-phonon interaction is one of the cornerstones of condensed matter physics. It is a major scattering mechanism that is charge carrier mobility in bulk semiconductor forms the basis of conventional superconductivity and spatianeous net magnetization at the atomic level, even in the asternal magnetis field. Example: Iron, Cobalt, Nickel etc. (e) In a ferromagnetic material susceptibility is very large and positive. (f) In a ferromagnetic material susceptibility is very large and positive. (g) Temporary magnets (h) Permanent magnets (c) Weak magnets (d) None of these Konkan Railway STA -2017 RRB SSE Mumbai 05.10.2008 Ans. (a) : The materials having low retentivity are suitable for making temporary magnets. (f) Temporary magnets are made of soft magnetis materials. (g) Ferromagnetic anot convert an ordinary piece of iron into a magnet because of its weak power. 206. Above the curie temperature, the magneti properties of a ferromagnetic material perishes. Above the curie temperature the magneti properties of a ferromagnetic material perishes. Above the curie temperature theromagnetic material become of a large systeresis loss due to large hysteresis loss due to large hy	(a) Very small and positive	Ans. (b) : Cooper pair is a weak electron - electron
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 (d) Very large and negative RRB JE Mumbai 05.10.2008 RRB JE Mumbai 05.10.2008 Interaction is one of the cornerstones of condensed materials are those materials which exhibit a spontaneous net magnetization at the atomic level, even In a ferromagnetic material, susceptibility is very large and positive. In a ferromagnetic material, susceptibility is very large and positive. li is strongly attracted to a magnate. (c) Koak magnets (d) None of these Konkan Railway STA - 2017 RRB SSE Mumbai 05.10.2008 Ans. (a) : The materials having low retentivity are suitable for making temporary magnets. Temporary magnets (d) None of these Konkan Railway STA - 2017 RRB SSE Mumbai 05.10.2008 Ans. (a) : The materials having low retentivity are suitable for making temporary magnets. Temporary magnets are made of soft magnetic or to a magnet because of its weak power. Co. Above the curie temperature, the magneti properties of a ferromagnetic material: (a) Ferrimagnetic materials (b) Moderately changes (c) Show simprovement (d) Remains unaffected DMRC Electronics 11.04.2018, 12:15 to 2:30 PM RB Chennai Technical (Eagg.) 15.04.207 Ans. (a) : Above the curie temperature material properties of a ferromagnetic material properties of a ferromagnetic material becomp prompagnetic material - Pt, Cr, Na, At and O2 Perromagnetic material - Fe, Ni, Co, Steel. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 unuits? <th>(c) Very small and negative</th> <td>Electron-phonon interaction- The electron-phonon</td>	(c) Very small and negative	Electron-phonon interaction- The electron-phonon
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 of iron into a magnet because of its weak power. 206. Above the curie temperature, the magnetic properties of a ferromagnetic material: (a) Perishes (b) Moderately changes (c) Shows improvement (d) Remains unaffected DMRC Electronics 11.04.2018, 12:15 to 2:30 PM RRB Chennai Technical (Engg.) 15.04.2007 Ans. (a) : Above the curie temperature the magnetic properties of a ferromagnetic material become paramagnetic material. Paramagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Fe, Ni, Co, Steel. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? (b) Super magnetic materials (c) Soft magnetic materials (d) Hard magnetic materials (d) Hard magnetic materials:- (e) Coercivity and retentivity are high They have low permeability Magnetic energy stored is high The magnetic material can not be easily magnetize and demagnetize Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 	• Temporary magnet cannot convert an ordinary piece	(a) Ferrimagnetic materials
 206. Above the curie temperature, the magnetic properties of a ferromagnetic material: (a) Perishes (b) Moderately changes (c) Shows improvement (d) Remains unaffected DMRC Electronics 11.04.2018, 12:15 to 2:30 PM RRB Chennai Technical (Engg.) 15.04.2007 Ans. (a) : Above the curie temperature the magnetic properties of a ferromagnetic material perishes. Above curie temperature ferromagnetic material become paramagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Pt, Cr, Na, Al and O₂ They have large hysteresis loss due to large hysteresis loop area. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? (c) Soft magnetic materials (d) Hard magnetic materials (e) Coercivity and retentivity are high They have low permeability Magnetic energy stored is high The magnetic material can not be easily magnetize and demagnetize Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 	of iron into a magnet because of its weak power.	(b) Super magnetic materials
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 (b) Moderately changes (c) Shows improvement (d) Remains unaffected DMRC Electronics 11.04.2018, 12:15 to 2:30 PM RRB Chennai Technical (Engg.) 15.04.2007 Ans. (a) : Above the curie temperature the magnetic properties of a ferromagnetic material perishes. Above curie temperature ferromagnetic material become paramagnetic material. Paramagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Fe, Ni, Co, Steel. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? Ans. (d) : Hard magnetic materials :- Coercivity and retentivity are high They have low permeability Magnetic energy stored is high The magnetic material can not be easily magnetize and demagnetize Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 	(a) Perishes	UPMRCL JE 03.01.2023, 1:30 PM- 3:30 PM
 (c) Shows improvement (d) Remains unaffected DMRC Electronics 11.04.2018, 12:15 to 2:30 PM RRB Chennai Technical (Engg.) 15.04.2007 Ans. (a) : Above the curie temperature the magnetic properties of a ferromagnetic material perishes. Above curie temperature ferromagnetic material become paramagnetic material. Paramagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Fe, Ni, Co, Steel. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? Coercivity and retentivity are high They have low permeability Magnetic energy stored is high The magnetic material can not be easily magnetize and demagnetize Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 211. The material used for making permanent magnets should have : (a) Low retentivity, Low permeability, High coercivity (b) High retentivity, Low permeability, Low 	(b) Moderately changes	Ans. (d) : Hard magnetic materials :-
 (d) Remains unaffected DMRC Electronics 11.04.2018, 12:15 to 2:30 PM RRB Chennai Technical (Engg.) 15.04.2007 Ans. (a) : Above the curie temperature the magnetic properties of a ferromagnetic material perishes. Above curie temperature ferromagnetic material become paramagnetic material. Paramagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Fe, Ni, Co, Steel. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? They have low permeability Magnetic energy stored is high The magnetic energy stored is high The material can not be easily magnetize and demagnetize Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 211. The material used for making permanent magnets should have : (a) Low retentivity, Low permeability, High coercivity (b) High retentivity, Low permeability, Low 	(c) Shows improvement	• Coercivity and retentivity are high
 Magnetic energy stored is high The magnetic material can not be easily magnetize and demagnetize Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? Magnetic energy stored is high Magnetic energy stored is high Magnetic energy stored is high The magnetic material can not be easily magnetize and demagnetize Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 211. The material used for making permanent magnets should have : (a) Low retentivity, Low permeability, High coercivity (b) High retentivity, Low permeability, Low 	(d) Remains unaffected	• They have low permeability
 Ans. (a) : Above the curie temperature the magnetic properties of a ferromagnetic material perishes. Above curie temperature ferromagnetic material become paramagnetic material. Paramagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Fe, Ni, Co, Steel. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? The magnetic material can not be easily magnetize and demagnetize Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 211. The material used for making permanent magnets should have : (a) Low retentivity, Low permeability, High coercivity (b) High retentivity, Low permeability, Low 	DMRC Electronics 11.04.2018, 12:15 to 2:30 PM RRR Channei Technical (Engg.) 15.04.2007	 Magnetic energy stored is high
 Ans. (a) . Above the curve temperature the magnetic material perishes. Above curve temperature ferromagnetic material perishes. Above paramagnetic material. Paramagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Fe, Ni, Co, Steel. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? and demagnetize Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 211. The material used for making permanent magnets should have : (a) Low retentivity, Low permeability, High coercivity (b) High retentivity, Low permeability, Low 	Ans (a) · Above the curie temperature the magnetic	• The magnetic material can not be easily magnetize
 Susceptibility is low Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? Susceptibility is low They have large hysteresis loss due to large hysteresis loop area. 211. The material used for making permanent magnets should have : (a) Low retentivity, Low permeability, High coercivity (b) High retentivity, Low permeability, Low 	properties of a ferromagnetic material perishes. Above	and demagnetize
 paramagnetic material. Paramagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Fe, Ni, Co, Steel. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? • They have large hysteresis loss due to large hysteresis loop area. 211. The material used for making permanent magnets should have : (a) Low retentivity, Low permeability, High coercivity (b) High retentivity, Low permeability, Low 	curie temperature ferromagnetic material become	• Susceptibility is low
 Paramagnetic material - Pt, Cr, Na, Al and O₂ Ferromagnetic material - Fe, Ni, Co, Steel. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? Inysteresis loop area. 211. The material used for making permanent magnets should have : (a) Low retentivity, Low permeability, High coercivity (b) High retentivity, Low permeability, Low 	paramagnetic material.	• They have large hysteresis loss due to large
 Ferromagnetic material - Fe, Ni, Co, Steel. 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? 211. The material used for making permanent magnets should have : (a) Low retentivity, Low permeability, High coercivity (b) High retentivity, Low permeability, Low 	Paramagnetic material - Pt, Cr, Na, A ℓ and O ₂	nysteresis loop area.
 207. What is the internal field when applied field is 24 units, molecular field constant is 0.2 units and the magnetization is 84 units? (a) Low retentivity, Low permeability, High coercivity (b) High retentivity, Low permeability, Low 	Ferromagnetic material - Fe, Ni, Co, Steel	211. The material used for making permanent
24 units, molecular field constant is 0.2 units and the magnetization is 84 units? (a) Low retentivity, Low permeability, High (b) High retentivity, Low permeability, Low	207 What is the internal field when annlied field is	(a) Low retentivity Low permechility High
and the magnetization is 84 units? (b) High retentivity, Low permeability, Low	24 units. molecular field constant is 0.2 units	coercivity
8 (*)	and the magnetization is 84 units?	(b) High retentivity. Low permeability. Low
(a) 20.4 (b) 30.8 coercivity	(a) 20.4 (b) 30.8	coercivity
(c) 16.6 (d) 40.8 (c) High permeability, Low retentivity, Low	(c) 16.6 (d) 40.8	(c) High permeability, Low retentivity, Low
UPMRCL JE 03.01.2023, 1:30 PM- 3:30 PM coercivity	UPMRCL JE 03.01.2023, 1:30 PM- 3:30 PM	coercivity
Ans. (d) : Given, (d) High retentivity, High permeability, High	Ans. (d) : Given,	(d) High retentivity, High permeability, High
Molecular field $(\chi) = 0.2$ units	Molecular field $(\chi) = 0.2$ units	coercivity
Magnetization (M) = 84 units $(N = 84 \text{ units})$	Magnetization $(M) = 84$ units	Konkan Railway SSE-2015
Applied field (H_0) = 24 units [] Ans (d) : Permanent magnet are those magnet. They do	Applied field $(H_0) = 24$ units	Ans (d) : Permanent magnet are those magnet. They do
I I Inot lose their magnetic property once they are	The internal field of a magnetic material is given by	most lose their magnetic property once they are
The internal field of a magnetic material is given by	$H = H_0 + (\gamma) M$	Property of permanent megnet
The internal field of a magnetic material is given by $H = H_0 + (\gamma) M$	$H = 24 + 0.2 \times 84$	(i) High permeability
The internal field of a magnetic material is given by $H = H_0 + (\chi) M$ $H = 24 + 0.2 \times 84$ (i) High nermeability	$11 = 24 + 0.2 \land 04$	(ii) High correlativ
The internal field of a magnetic material is given by $H = H_0 + (\chi) M$ $H = 24 + 0.2 \times 84$ $H = 24 + 16.8$ Internal field of a magnetic material is given by magnetised. Property of permanent magnet - (i) High permeability (ii) High coercivity	$H = 24 \pm 16.8$	

212. When the slightly less (a) diama (b) param (c) ferron (d) none	relative permeabil ss than 1, it is called gnetic material agnetic material nagnetic material RRB Chandiga RRB Allahab	ity of a material is l a rh SSE-25.10.2009 ad SSE-19.12.2010	 216. Superconductors now a day found their application in various fields. This is due to the fact that they: (a) generate regions free from magnetic field (b) manufacture bubble memories (c) generate electrostatic field (d) generate very strong magnetic field RRB Chandigarh SSE 25.10.2009
Ans: (a) When is slightly less material.	the relative permea than 1, it is call	bility of a material ed a diamagnetic	DFCCIL EE 17.04.2016, Shift-II Ans. (d) : Super conductor now a day found their application in various field. This is due to the fact that
Material	Relative permeability µ _r	Example	they generate very strong magnetic field. Such substances or metal in which the value of
Non-magnetic	$\mu_r = 1$	Glass, Air, Wood	resistivity decrease very rapidly at a certain temperature
Diamagnetic	$\mu_r < 1$	Copper, Silver, Carbon, Bismuth	superconducting substances and this property is called
Paramagnetic	1< μ _r	Aluminium, Magnesium, Lithium	superconductivity. Superconductor generate high electromagnetic field so, they are used in magnetic resonance imagining and
Ferromagnetic	$\mu_r >> 1$	Iron, Nickel, Cobalt	217. The magnetism left in the iron after exciting
213. If a ferrer Curie tem (a) Perma (b) Anti-f (c) Diama (d) Param	omagnetic materia perature, it become unent magnet erromagnetic materi agnetic material agnetic material	il is heated upto es al	field has been removed is known as (a) Reluctance (b) Performance (c) Susceptance (d) Residual magnetism RRB Kolkata Engg-20.02.2000 RRB SSE Mumbai 19.12.2010 Ans : (d) The magnetism left in the iron after exciting
 Ans : (d) If a curie temperature Paramagnetic m and have posi material net aton zero. The atom permanent dipole Ex Al, Na, Pt, 214. Which on can be cat (a) plastic (c) alloys 	Konkan ferromagnetic mate ferromagnetic mate aterial have very stive susceptibility. mic dipole moment n of paramagnetic e moment due to unp Mn e of the following of egorized as ferrites cs (b) (d) Konkan	Railway STA 2017 rial is heated upto agnetic material. small susceptibility In paramagnetic of an atom is not substances have aired spin. classes of material ? metals ceramics Railway STA-2017	 Residual magnetism occurs when a magnet fails to turn completely off. 218. Which of the following is generally used to make Permanent magnets? (a) Cast iron (b) Silicon steel (c) Permalloy (d) Cobalt steel Konkan Railway STA 2017 Ans : (d) Cobalt steel is used to make permanent magnet. A permanent magnet is one that retains its magnetic properties for a long period of time. Ex iron, nickel, cobalt etc. 219. The reluctance offered by a magnetic material is highest when it is (a) Disparamentia (b) Disparamentation
Ans : (d) Ceramin The ferrite perma magnet and even ferromagnetic Cera and barium or stro 215. Which of soft magnet (a) High c (b) Low re (c) Highen (d) Larger LMRC SC Ans. (b) : Soft magnetization. I demagnetize. Characteristic o (1) It has high pe (2) It has low coe (3) It has small h	cs can be categorized nent magnet is also n as hard ferrite n ramic material comp ontium and molybden the following is a etic material? oercivity emnant magnetization hysteresis loss area enclosed by the Konkan CTO (Electronics) 1 magnetic material t is easy to magn f soft material - rmeability. ercive force. ysteresis losses and 1	as ferrites. known as a ceramic hagnet. Ferrites are ound of iron, boron um. characteristic of a m eir hysteresis loop Railway SSE-2015 16.04.2018, Shift-II has low remnant etize and easy to lower retentivity.	(c) Ferromagnetic (d) None of these RRB Chandigarh SSE-25.10.2009 Ans : (a) The reluctance offered by a magnetic material is highest when it is diamagnetic material. Diamagnetic materials are substance that are usually repelled by a magnetic field. Magnetic susceptibility is small and negative. 220. The relative permeability of air is (a) zero (b) 1 (c) infinity (d) None of these RRB JE Mumbai 19.12.2010 Ans : (b) :- Relative permeability is known to be a dimension less quantity and it is the ratio of two quantities with the same unit.

 221. Which of the following metals is particularly suitable for operations in very high ambient temperatures? (a) Gold (b) Silver (c) Copper (d) Aluminium DFCCIL Executive (EE) -30.09.2021 	Ans. (a) : Constantan:- It is a copper and nickel alloy used in the production of thermocouples and thermocouple extension wire as well as precision resistor and two temperature resistance heating application. Constantan = Cu (60%) + Ni (40%)
Ans. (d) : Aluminium is suitable for operation in very high ambient temperature. Ambient temperature is the air temperature of any object or environment where	226. Which of the following materials has the highest melting point?
equipment is stored.	(c) Copper (d) Aluminum
222. Which of the following materials is used	DMRC Electronics 17.02.2017, 12:00 – 2:15 PM
thermionic valves and sparking plugs?	Delhi Metro Electronic JE 2017
(a) Graphite (b) Lead	Melting point of tungsten 3400 °C.
(c) Nickel (d) Tin DECCH Executive (EE) 30.09.2021	Metal Melting Point
Ans. (c) : Nickel is used extensively for making the	Aluminium - 658 °C
electrodes of thermionic valves and sparking plugs.	Silver - 961 °C
Properties of nickel -	227. What type of temperature coefficient of
(i) The metal dissolves slowly in dilute acids	thermistors have?
(iii)Nickel is a silvery-white, hardness, malleable and	(a) Positive (b) Negative
ductile metal.	(c) Either positive or negative
223. When majority of domains get aligned, the magnetic material is said to be:	(d) None of these
(a) Saturated	DMRC Electronic, 2014
(b) Soft magnetic material	temperature co-efficient.
(c) Linear (d) Ideal material	Negative temperature co-efficient thermistor -
LMRC JE (S&T)-12.05.2018	Negative temperature co-efficient thermistor are resistor that the resistance decreases with increasing
RRB Allahabad SSE 19.12.2010	temperature. They are primarily used as resistive
Ans : (a) When majority of domain get aligned the magnetic material is said to be saturated	temperature sensors and current-limiting devices.
If we increase the magnetic field then the magnetic field	Positive temperature co-efficient thermistor -
applies torques on each dipole and hence dipoles rotate	temperature dependent resistor based on special
material reaches saturation magnetization and no	semiconductor Ceramics with a high positive temperature co-efficient
increase in magnetization will take place on further	228. Material which take permanent magnetic
Increase in strength of magnetic field.	dipoles are known as.
$ \downarrow \downarrow$	(a) Paramagnetic (b) Diamagnetic (c) Ferromagnetic (d) Ferrimagnetic
$\swarrow \backslash \land $	RRB SSE Mumbai 19.12.2010
non-aligned domains aligned domains	DMRC Electronic, 2016
224. Copper, Silver, Diamond are examples of :	Ans : (c) Ferromagnetic material have permanent
(b) Paramagnetic substances	group of substances that when applied to magnetic field
(c) Ferromagnetic substance	exhibit strong magnetism in the direction of the field.
(d) Ferrimagnetic substances PPR Allababad SSE 10 12 2010	Ex Fe. Co. Ni etc.
Ans : (a) The diamagnetic material does not have	229. B-H curve can be used for determination of–
permanent dipole moment and the value of spontaneous	(a) hysteresis losses
polarization is zero. If a magnetic field is applied then it repelled therefore magnetic suscentibility of	(b) iron losses (c) eddy current losses
diamagnetic material is small and negative.	(d) both hysteresis losses and iron losses
225. The composition of constantan is:	LMRC SCTO Shift-I-2016
(a) $Cu = 60\%$ and $N_1 = 40\%$ (b) $Cu = 43\%$ $N_1 = 17\%$ and $M_2 = 40\%$	JMRC JE 10.06.2017
(c) $Sn = 23.43\%$, $Cu = 43.67\%$ and $Ni = 32.9\%$	both hysteresis losses and iron losses. B-H curve is used
(d) $Mn = 65\%$ and $Zn = 35\%$	to relationship between magnetic flux density (B) and
UPMRC JE- 20.01.2020, 4:00 to 6:00 PM DMRC Electronics 17.02 2017 12:00 2:15 PM	magnetic field strength (H) for a particular material. The B-
Delhi Metro Electronics JE 2017	properties such material by characterizing the permeability.

230. The following materials are diamagnetic	Ans: (d) Given that–
materials except :	$\mu_{\rm r} = 1000$
(a) Copper (b) Bismuth (c) Iron (d) Germanium	$\mu = \mu_0 \mu_r$
DMRC JE 20.04.2018	$=4\pi \times 10^{-7} \times 1000$
DMRC Electronics 17.02.2017, 12:00 – 2:15 PM	$= 4\pi \times 10^{-4} \text{ H/m}$
Delhi Metro Electronic JE 2017	235. A ferromagnetic material exhibits different
BEL-21.06.2015	characterstics above and below the-
Ans : (c) Diamagnetic material are substances that are	(a) Joule's temperature
usually repelled by magnetic field. Diamagnetic material	(b) Faraday temperature
does not have permanent dipole moment. Magnetic	(c) Curie temperature
Ex Cu. Ge. Bi.	(d) Neel temperature
231. The hysteresis loss in a given magnetic material	Ans · (c) A ferromagnetic material exhibits different
can be reduced	characteristics above and below the curie temperature.
(a) By laminating it	Ferromagnetic properties depend on temperature. At
(b) By increasing it flux	high temperature ferromagnetic material become
(c) Increasing the frequency of reversal of	paramagnetic. The temperature at which this transition
(d) Reducing the maximum flux density	occurs is called the curie temperature.
(a) Reducing the maximum flux density established by it	236. Material which take permanent magnetic
RRB Guwahati Electronic – 2014	dipoles are known as.
Ans : (d) The hysteresis loss in a magnetic material can	(a) Ferromagnetic (d) Ferrimagnetic
be reduced, when maximum flux density reduce.	DMRC Electronic, 2016
During the cycle of magnetization and demagnetization	Ans : (c) Ferromagnetic material have permanent
of magnetic substance energy is spent and this is spent	magnet dipole. Ferromagnetic substances are a certain
energy appears in the form of heat. This heat loss is	group of substances that when applied to magnetic field
KIIOWII as Hysteresis loss. $W = mD^{1.6} + f V$	exhibit strong magnetism in the direction of the field.
$\mathbf{W}_{h} = \mathbf{\eta} \mathbf{B}_{max} \cdot 1 \cdot \mathbf{V}$	Most of the ferromagnetic substances are metal.
$W_h \propto B_{max}^{1.6}$	EX Fe, Co, NI etc.
232 Vacuum is considered	behind the magnetising force applied is called:
(a) Non-magnetic material	(a) Reluctance (b) Hysteresis
(b) Diamagnetic material	(c) Eddy current (d) Permeance
(c) Paramagnetic material	Noida Metro Electronic JE 2017
(d) Ferromagnetic material	Ans : (b) The lagging of flux density of the material
RRB Guwahati Electronic 2014	behind the magnetising force applied is called
Ans : (a) Vacuum is considered as non-magnetic	Hysteresis. Thus magnetic hysteresis is that property of a magnetic material. Due to which some energy is lost in
are not attracted by a magnet. They are not canable to be	it on magnetization reversal.
magnetized by an external source. Non-magnetic	238. The disc of an instrument using eddy current
material are rubber, plastic, wood, paper, mica etc.	damping should be of:
233. Which of the following is a paramagnetic	(a) conducting and magnetic material
material	(b) non-conducting and magnetic material
(a) Iron (b) Nickel	(c) conducting and non-magnetic material
(c) I antalum (d) Cobalt I MPC SCTO (Floatropics) 16.04.2018 Shift II	(d) non conducting and non magnetic material I MBC SCTO Shift I 2016
Ans (c) · Paramagnetic material have very small	Ans : (c) The disc of an instrument using eddy current
susceptibility and have positive susceptibility. In	damping should be of conducting and non-magnetic
paramagnetic material net atomic dipole moment of an	material. For eddy current damping a thin aluminum
atom is not zero. The atom of paramagnetic substances	disc attached to the moving system of the instrument this
have permanent dipole moment due to unpaired spin,	disc moves in the field of a permanent magnet the disc
relative permeability is slightly greater than 1.	snould be of conducting and non-magnetic material.
EX AI, SI, PI, Mg, MII, and Ia.	239. Hysteresis error, in moving iron instruments,
234. The relative permeability of a terromagnetic substance is 1000. The absolute normeability of	(a) mumetal or permallov
the substance is :	(b) stainless steel
(a) $4\pi \times 10^{-6}$ H/m (b) $4\pi \times 10^{-7}$ H/m	
	(c) silver coating
(c) $4\pi \times 10^{-11}$ H/m (d) $4\pi \times 10^{-4}$ H/m	(c) silver coating (d) high speed steel

Ans : (a) Hysteresis error in moving iron instruments may be reduced by using mumetal or permalloy because hysteresis loop will be small. Permalloy = Ni(78%) + Fe(22%) Mumetal = Ni(77%) + Fe(14%) + Cu(5%) + Cr(4%)	 244. Composition of manganin is: (a) Copper =86%, Manganese = 12%, Nickel=2% (b) Copper=76%, Manganese=42%, Nickel=24% (c) Copper = 56%, Manganese = 42%, Nickel = 2% (d) Copper = 54%, Nickel = 46% LMRC JE (S&T) 12.05.2018
 240. Reluctance is the property of a material to: (a) oppose the creation of magnetic flux in it (b) allow the flow of electrons through it (c) oppose the flow of electrons through it (d) allow magnetic flux through it Delhi Metro Electronic JE 2017 	Ans : (a) Maganin alloy contain Copper, Nickel and Manganese. Constantan is also used to make standard resistance in practical use. Constantan = Copper (86%) + Mn (12%) + Ni (2%) Brass = Cu (67%) + Zn (33%) Eureka = Cu (60%) + Ni (40%)
Ans : (a) Reluctance is the property of a material to oppose the creation of magnetic flux in it. The unit of reluctance is ampere-turns per weber or $(Henry)^{-1}$. Reluctance is the property of a magnetic circuit opposing the posses of magnetic flux lines equal to the ratio of the magneto motive force to the magnetic flux. [MMF = reluctance × Flux]	 243. When a rubber test sample is subjected to an increase in ambient temperature: (a) Volumetric resistance increases (b) There is no change in volumetric resistance (c) Volumetric resistance decreases (d) There is a decrease in conductivity LMRC JE (S&T) 12.05.2018 Ans : (c) When a rubber test sample is subjected to an increase in ambient temperature volumetric resistance decreases
241. Relative permittivity of Air or Vacuum is: (a) 1 (b) 3 to 5 (c) 0 (d) 2 Noida Metro Electronic JE 2017 NMRC Electronics 09.03.2017, 8:30 – 10:45 AM Ans : (a) Relative permittivity of Air or Vacuum is 1.	246. Which of the following can be classified as a paramagnetic substance? (a) Nickel (b) Aluminium (c) Copper (d) Bismuth DMRC Electronics 19.04.2018, 12:15 to 2:30 PM
$\begin{bmatrix} \varepsilon_r = \frac{\varepsilon}{\varepsilon_0} \end{bmatrix}$ The relative permittivity is the permittivity of a material expressed as a ratio with the electric permittivity of a vacuum. 242. For high frequency operation, iron or ferrite slugs can be replaced by	Ans. (b) : The magnetic susceptibility of paramagnetic material is less than one but positive. Paramagnetic material have very small and positive susceptibility. In paramagnetic material net atomic dipole moment of an atom is not zero. The atom of paramagnetic substances have permanent dipole moment due to unpaired spin. Relative permeability is slightly greater than 1. Ex $A\ell$, Sn, Pt, Mg, Mn and Ta.
 (a) Steel slug (b) Copper slug (c) Brass slug (d) Silicon slug DMRC Electronics 19.04.2018, 12:15 to 2:30 PM Ans. (c) : For high frequency operation; iron or ferrite slugs can be replace by brass slug. This reduces the coil reluctance and reducing the Q-factor. However fine tuning of RF, VHF and UHF is possible using a brass slug. The slug is inserted into a threaded holder, which fits around the coil into the core-bottom and core-top. The coil inductance of the core charges by changing the slug position.	 247. Materials subjected to rapid reversals of magnetism should have : (a) large area of hysteresis loop (b) high permeability and low hysteresis loss (c) high retentivity and high coercivity (d) high permeability and good residual magnetism DMRC Electronics 11.04.2018, 4:30 to 6.45 PM Ans. (b) : Materials subjected to rapid reversals of magnetism should have high permeability and low hysteresis loss. the requirement of magnetic material for use in machine
 243. For which of the following resistance of the material increases with temperature? (a) Semiconductors (b) Insulators (c) Eureka (d) Alloys LMRC SCTO (Electronics) 16.04.2018, Shift-II Ans. (d) : Generally metal (Cu, Aℓ) and alloys have positive temperature co-efficient as their resistance increases with increase in temperature. Semiconductor 	 and transformer are - (i) Flux density should have a high saturation value. (ii) Hysteresis loop should have a small area. (iii) magnetism should be high. 248. Eddy current Losses can be reduced by using thin sheet of laminated with which (a) CRGO Steel (b) HRGO Steel (c) Cost-iron (d) Silicon DMRC Electronics 17.02.2017, 8:30 to 10:45 AM
and insulator have negative temperature co-efficient because resistance decrease when temperature increase. Ex. – Alloys : Brass, Bronze, Constantan. Semiconductor : Silicon, Germanium, Gallium Arsenide Insulator : Mica, Wood, Paper, Glass.	Ans. (a) : Eddy current losses can be reduced by using thin sheet of laminated with which CRGO steel. $W_e = \eta B_{max}^2 f^2 t^2 V$ Watt Where, $\eta = Eddy$ current constant $B_{max} = Maximum$ flux density in the core f = Supply frequency t = Thickness of lamination



259. Which material does the following figure	(c) Para - magnet (d) Alnico - magnet
represent -	UPMRCL JE 03.01.2023, 1:30 PM- 3:30 PM
$\uparrow \uparrow \uparrow \uparrow \uparrow$	RRB Mumbai SSE-05.10.2008
(a) Diamagnetic (b) Ferromagnetic	Ans. (d) : Alnico magnet has the highest energy per
(c) Paramagnetic (d) Ferrimagnetic	unit of cost of volume of only permanent magnet
RRB Chandigarh SSE-26.02.2012	Alpico allows are forromagnetic and used to make
Ans. (b): $\uparrow \uparrow \uparrow \uparrow \uparrow$	• Affice alloys are refromagnetic and used to make
Figure represent the ferromagnetic material A	• The composition of alpico alloys is typically 8-12%
ferromagnetic material is a substance by which	Al. $(15-26)$ % Ni. $(5-24)$ % Co. upto 6% Cu. upto 1%
permanent magnetism is created. It is magnetized	Ti and the rest is Fe.
externally, it remain magnetized even when the	265. The coercive force in ferromagnetic material is
magnetic field is removed.	related to the:
260. Ferrite cores are used as they help in:	(a) Area enclosed by the B-H loop
(a) Reducing the eddy currents	(b) Intercept on the negative H-axis of the B-H
(b) Reducing the magnetic permeability	
(c) Increasing the electrical conductivity	(c) Intercept on the positive B-axis of the B-H
(d) Being more brittle	(d) Maximum value of B on the B-H loon
RRB Mumbai JE 05.10.2008	LMRC IF Flectronics 2016 2013
Ans. (a) : Ferrite cores are used as they help in reducing	Ans : (b) The coercive force in ferromagnetic material
the eddy currents. The magnetic permeability and	is related to the intercept on the negative H-axis of the
resistivity of a territe core is very night. Due to night	B-H loop.
currents generated in the core	B↑
261 If the relative permittivity of glass is 8 what	D
will be its absolute permittivity?	Retentivity A B
(a) $8 + \varepsilon_0$ (b) $8\varepsilon_0$	
(c) $8/\epsilon_0$ (d) $\epsilon_0/8$	C
DMRC Electronics 11.04.2018, 4:30 to 6.45 PM	Coercivity
RRB Mumbai JE 05.10.2008	
Ang (b) + Given that	
Alis. (b) : Orven that -	Point UA show coercive force
$\epsilon_r = 8$	266. For high frequency operation, iron or ferrite
$\begin{aligned} & \kappa_r = 8 \\ & \epsilon_0 = \text{Permittivity of air} \end{aligned}$	266. For high frequency operation, iron or ferrite slugs can be replaced by
Ans. (b) : Given that - $\varepsilon_r = 8$ $\varepsilon_0 = Permittivity of air Absolute permittivity \varepsilon = \varepsilon_r \varepsilon_0$	 266. For high frequency operation, iron or ferrite slugs can be replaced by (a) Steel slug (b) Copper slug
Ans. (b) : Given that - $\varepsilon_r = 8$ $\varepsilon_0 = \text{Permittivity of air}$ Absolute permittivity $\varepsilon = \varepsilon_r \varepsilon_0$ $\varepsilon = 8\varepsilon_0$	266. For high frequency operation, iron or ferrite slugs can be replaced by (a) Steel slug (b) Copper slug (c) Brass slug (d) Silicon slug
Ans. (b) : Given that - $\varepsilon_r = 8$ $\varepsilon_0 = Permittivity of air Absolute permittivity \varepsilon = \varepsilon_r \varepsilon_0\varepsilon = 8\varepsilon_0262. Material which take permanent magnetic$	Point OA show coercive force. 266. For high frequency operation, iron or ferrite slugs can be replaced by (a) Steel slug (b) Copper slug (c) Brass slug (d) Silicon slug DMRC Electronics 19.04.2018, 12:15 to 2:30 PM
Ans. (b) : Given that - $\varepsilon_r = 8$ $\varepsilon_0 = Permittivity of air Absolute permittivity \varepsilon = \varepsilon_r \varepsilon_0\varepsilon = 8\varepsilon_0262. Material which take permanent magneticdipoles are known as.$	 Point OA show coercive force. 266. For high frequency operation, iron or ferrite slugs can be replaced by (a) Steel slug (b) Copper slug (c) Brass slug (d) Silicon slug DMRC Electronics 19.04.2018, 12:15 to 2:30 PM RRB Chandigarh SSE-26.02.2012
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Ans. (b) : Given that - $\varepsilon_r = 8$ $\varepsilon_0 = Permittivity of air Absolute permittivity \varepsilon = \varepsilon_r \varepsilon_0\varepsilon = 8\varepsilon_0262. Material which take permanent magneticdipoles are known as.(a) Paramagnetic (b) Diamagnetic(c) Ferromagnetic (d) FerrimagneticDMPC Eleatronic 2016$	266. For high frequency operation, iron or ferrite slugs can be replaced by (a) Steel slug (b) Copper slug (c) Brass slug (d) Silicon slug DMRC Electronics 19.04.2018, 12:15 to 2:30 PM RRB Chandigarh SSE-26.02.2012 Ans. (c) : For high frequency operation; iron or ferrite slugs can be replace by brass slug. This reduces the coil reluctance and reducing the O-factor. However, fine
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Ans. (b) : Orden that - $\varepsilon_r = 8$ $\varepsilon_0 = Permittivity of airAbsolute permittivity \varepsilon = \varepsilon_r \varepsilon_0\varepsilon = 8\varepsilon_0262. Material which take permanent magneticdipoles are known as.(a) Paramagnetic(b) Diamagnetic(c) Ferromagnetic(d) FerrimagneticDMRC Electronic, 2016Ans : (c) Ferromagnetic material have permanentmagnet dipole. Ferromagnetic substances are a certaingroup of substances that when applied to magnetic fieldexhibit strong magnetism in the direction of the field.Most of the ferromagnetic substances are metal.Ex Fe, Co, Ni etc.263. Magnetic moment is the(a) Pole strength(b) Vector quantity(c) Scalar quantity(d) Universal constantRRB Mumbai SSE-05.10.2008Ans : (b) Magnetic moment is the vector quantity.\tau = m \times B\tau = Torque acting on the dipolem = Magnetic momentBm = External magnetic field$	 Point OA show coercive force. 266. For high frequency operation, iron or ferrite slugs can be replaced by (a) Steel slug (b) Copper slug (c) Brass slug (d) Silicon slug DMRC Electronics 19.04.2018, 12:15 to 2:30 PM RRB Chandigarh SSE-26.02.2012 Ans. (c) : For high frequency operation; iron or ferrite slugs can be replace by brass slug. This reduces the coil reluctance and reducing the Q-factor. However fine tuning of RF, VHF and UHF is possible using a brass slug. The slug is inserted into a threaded holder, which fits around the coil into the core-bottom and core-top. The coil inductance of the core charges by changing the slug position. 267. Copper, Silver, Diamond are examples of : (a) Diamagnetic substance (b) Paramagnetic substances (c) Ferromagnetic substances (d) Ferrimagnetic material does not have permanent dipole moment and the value of spontaneous polarization is zero. If a magnetic susceptibility of
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Ans. (b) : Given that - $\varepsilon_r = 8$ $\varepsilon_0 = Permittivity of air Absolute permittivity \varepsilon = \varepsilon_r \varepsilon_0\varepsilon = 8\varepsilon_0262. Material which take permanent magneticdipoles are known as.(a) Paramagnetic (b) Diamagnetic(c) Ferromagnetic (d) FerrimagneticDMRC Electronic, 2016Ans : (c) Ferromagnetic material have permanentmagnet dipole. Ferromagnetic substances are a certaingroup of substances that when applied to magnetic fieldexhibit strong magnetism in the direction of the field.Most of the ferromagnetic substances are metal.Ex Fe, Co, Ni etc.263. Magnetic moment is the(a) Pole strength (b) Vector quantity(c) Scalar quantity (d) Universal constantRRB Mumbai SSE-05.10.2008Ans : (b) Magnetic moment is the vector quantity.\tau = m \times B\tau = Torque acting on the dipolem = Magnetic momentB = External magnetic field [m = IA]264. Which alloy have the highest energy per unit ofcost or volume of any permanent magnetmaterial commercially available?(b) Ferriment$	 Point OA show coercive force. 266. For high frequency operation, iron or ferrite slugs can be replaced by (a) Steel slug (b) Copper slug (c) Brass slug (d) Silicon slug DMRC Electronics 19.04.2018, 12:15 to 2:30 PM RRB Chandigarh SSE-26.02.2012 Ans. (c) : For high frequency operation; iron or ferrite slugs can be replace by brass slug. This reduces the coil reluctance and reducing the Q-factor. However fine tuning of RF, VHF and UHF is possible using a brass slug. The slug is inserted into a threaded holder, which fits around the coil into the core-bottom and core-top. The coil inductance of the core charges by changing the slug position. 267. Copper, Silver, Diamond are examples of : (a) Diamagnetic substance (b) Paramagnetic substances (c) Ferromagnetic substances (d) Ferrimagnetic substances (e) Ferromagnetic substances (f) Ferrimagnetic substances (g) The diamagnetic material does not have permanent dipole moment and the value of spontaneous polarization is zero. If a magnetic field is applied then it repelled therefore magnetic susceptibility of diamagnetic material is small and negative. 268. Which one of the following classes of material can be categorized as ferrites? (a) plastics (b) metals (c) alloys (d) ceramics



The material used to protect the cables from Ans. (c) : Liquid system is NOT the method of laying 281. moisture and dust is: of underground cables. (a) Lead (b) Carbon Method of laying of underground cables: (c) Copper (d) Nichrome 1. Direct laying 2. Draw-in-system **Delhi Metro Electronic JE 2017** Ans : (a) Lead sheath is used to protect the cables from 3. Solid system moisture and dust. Lead sheath protect the cable from 277. cables are used for operating voltage gases or the other damaging liquids (acid or alkalis) in up to 11000V. the soil and atmosphere. A metallic sheath of lead or (a) High voltage (b) Super tension aluminium is provided over the insulation. It has (c) Extra high tension (d) Extra super voltage minimum dielectric stress in a cable. DFCCIL Executive Electrical 20.12.2023, 4:30-6:30 PM Ans. (a): Classification of underground cables on the basis of voltage level-M B Voltage level (kV) Type of cable 282. Which of the following protects a cable against Low tension cable 0 - 1 kV mechanical injury-High tension cable 1 - 11 kV (b) Sheath (a) Bedding 11 - 33 kV Super tension cable (d) None of the above (c) Armouring Extra high tension cable 33 - 66 kV **RRB Chandigarh Electronic 2014** Extra super tension cable 66 kV and above Ans. (c) : Armouring protects the cable from 278. In the context of underground cable a mechanical damage. sheath of lead or alloy is provided around the Copper conductor Four core insulation to protect it against ingress of - Impregnated paper Fabric tape binder moisture, gases or other damaging liquids in the soil and atmosphere. Metallic sheath (a) insulator Bedding (b) non metallic Metallic armourings (c) metallic Serving (d) organic Construction of a cable DFCCIL Executive Electrical 20.12.2023, 4:30-6:30 PM Armouring- Armouring is provided over the bedding. Ans. (c) : In the context of underground cable a metallic Armouring consists of one or more layers of Sheath of lead or alloy is provided around the insulation galvanised steel wire or steel tape. to protect it against ingress of moisture gases or other -Layer of cable is according to CIMBAS. damaging liquids in the soil and atmosphere. Where 279. Which of the following is NOT the main C– Core B-Bedding requirement of the insulating materials used I- Insulation for cables ? A- Armouring (a) High dielectric strength S-Serving M– Metallic sheath (b) Low coefficient of thermal expansion 283. What is the safe current carrying Capacity of (c) High insulation resistance 10mm square PVC insulated single phase (d) High permittivity Copper Cable. DFCCIL Executive Electrical 20.12.2023, 4:30-6:30 PM (a) 10 Amps (b) 100 Amps Ans. (d) : The satisfactory operation of a cable depends (c) 40 Amps (d) 16 Amps to great extent upon the characteristics of insulation LMRC JE Electronics 2016, 2013 used. In general, the insulating material used in cables Ans. (c) : The safe current carrying capacity of 10mm should have the following properties. square PVC insulated single phase copper cable is 40 High dielectric strength to avoid electrical Amps. breakdown of the cable. Which conducting material used in electrical 284. High insulation resistance to avoid leakage current. wires and cable? High mechanical strength to withstand the (a) Zinc (b) Copper mechanical handling of cable. (c) Tin (d) Iron Non-inflammable. Konkan Railway TA-2017 Low relative permittivity. Ans. (b) : Copper are used as a conducting material in 280. Which material is used to protect the cable electrical wires and cables. from moisture and dust. **Property of copper conductor** (b) Glass (a) Copper Low resistivity (c) Carbon (d) Nichrome ■ High conductivity DMRC Electronics 17.02.2017, 12:00 - 2:15 PM ■ Melting point of copper is 1085°C Ans. (b) : Glass is used to protect the cable from ■ Boiling point of copper is 2562°C moisture and dust. In order to protect the cable from High ductility and malleability moisture gases or other damaging liquids (acids or ■ It is a good conductor of electricity alkalies) in the soil and atmosphere a metallic sheath of ■ It has low chemical reactivity. lead or aluminium is provided over the insulation.

 (a) welding (b) soldering (c) thermit welding (d) resistance butt welding RRB Ajmer Electronic-2014 Ans : (b) Copper conductor cable are joined by soldering. Copper conductors are joined by hard solder. Hard solder is an alloy of copper and zinc and soft solder is an alloy of lead (Pb) and tin (Sn). Melting point of hard solder is greater than other type of solder. So, it is used to solder the material such as copper, brass and iron etc. Thermit welding – It is used to joint the railway track. Resistance butt welding – It is used to joint the railway track. Resistance butt welding – It is used to weld tube rod and wire. 286. Recommended current density for a copper bus bar which is unenclosed should not exceed. (a) 165 A/sq. cm (b) 118 A/sq. cm (c) 178 A/sq. cm (d) 135 A/sq. cm (d) 135 A/sq. cm (c) 178 A/sq. cm (d) 135 A/sq. cm (d) All of these Line (d) All of these (d) All of the set (d) All of these (d) All of the set (d) All of the set (d) All of these (d) All of these (d) All of the set (d) All of the set
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(c) 178 A/sq. cm (d) 135 A/sq. cm (c) 178 A/sq. cm (d) 135 A/sq. cm (d) 135 A/sq. cm (d) 135 A/sq. cm (d) 135 A/sq. cm (e) Sufface of the conductor (f) Core of the conductor (f) Sufface of the conductor (f) Core of the conductor
(a) 105 A/sq. cm (b) 116 A/sq. cm (c) 178 A/sq. cm (d) 135 A/sq. cm (e) $200 2015$
(DDD SSE (41:9 HI) 02.00.2015) A = (1) + 1 + (1) + (
(RKB SSE (shift-fif), 02.09.2015) Ans. (d) : In a cable the voltage stress is maximum
Ans. (a) : The current density for a copper bus bar the core of the conductor.
square.cm. $g_{max} = \frac{2V}{D}$
The current density of copper bus bar must be $d\log \frac{D}{1}$
sufficient that it withstands against 165A/sq.cm.
sufficient that it with stand against 130A/sq. cm. D = Internal sheath diameter
■ According to IER 1956, bus-bar should not be d = diameter of core
erected at a minimum height of 2.75m. $V = Phase Voltage$
287. A caple is designated as YFY. What does it $g_{min} = \frac{2V}{D}$
(a) Copper conductor PVC insulated formed $D\log \frac{D}{d}$
wire/flat armoured PVC outer sheathed.
(b) Aluminium conductor Y connected round [Potential gradient will be minimum when Diog- armoured PVC sheathed
(c) Copper conductor XLPE insulated flat
(d) Aluminium conductor XLPE insulated flat
armoured XLPE sheathed 290. Cables in power transmission line and
Konkan Railway STA 2017 provided with inter sheaths to:
Ans: (a) A cable is designated as YFY, it indicates approx approximately (a) Minimize charging current (b) Minimize stress
armoured PVC outer sheathed. (c) Provide uniform stress distribution
The following codes are used for design the cable as (d) Minimize high voltage
per IS (Indian standards)-
Constitute Code letter Code letter
distribution. Sheath is provided over the insulation.
Aluminium conductor A 291. According to voltage, the cables for operating to voltage and the cables for operating to voltage a
PVC insulation Y voltage up to 33000 V are called
(a) Low votage calles
Steelsurp armour F (c) Super-tension cables
(d) Extra high tension cables
Steel double strip ermour
PVC outer sheath V
$\begin{array}{ $
288. What is the source of heat generation in cables? [Super tension cable -33 kV (a) Copper loss in conductor [Extra high voltage -66 kV
(b) Dielectric losses in cable insulation Extra super high tension cables – 132 kV and above
Electronic Component and Materials 44 YO

	$nCH_2 = CH - Cl \longrightarrow (-CH_2 - CH -)n$
(a) Gas-filled cable	Vinyl chloride
(b) Elasiomer insulated cable	Cl
(d) Vulcanised India Rubber (VIR) cables	Polyvinyl chloride
CPCL JE 2019	PVC is above 100-110°C become soft and below 0°C
DMRC JE 10.04.2018, Shift-II	become brittle.
Ans : (b) Elastomer insulated cable used for high	PVC use in cover of electric wire.
voltage application. This cable is popularly known as rubber cables and elastomers cables are preferred over	294. The material which tends to often above 110 °C and becomes brittle at subzero temperature is:
flexible. It applications use in crowded locations where	(a) Mica (b) Teflon
the bending is very small. This cable is available from	(c) Acrylic (d) PVC
low voltage to 33kV grade.	LMRC JE (S&T) 12.05.2018
293. The chemical composition of PVC is:	Ans : (d) The material which tends to often above 110°C and becomes brittle at subzero temperature is
H H H H	PVC.
	The chemical composition of PVC -
(a) <i>CCC</i>	H H H H
	$-\dot{\mathbf{C}}-\dot{\mathbf{C}}-\dot{\mathbf{C}}-\dot{\mathbf{C}}$
Cl H Cl H	
F F F F F	Polyvinyl chloride is a synthetic polymer which is
	formed by combining two chemical repeatedly to form a
(b)CCCC	large polymene cham.
	$n(H_2 = CH - C\ell) \longrightarrow (-CH_2 - CH_n)_n$
F F F F F	Vinyl chloride
H	Polyvinyl chloride
	295 is a material that is used to make cable
(c) $-C - C$	sheaths.
	(c) Lead (d) Cast iron
HH - C - H	DFCCIL EE 11.11.2018, 12:30 PM-2:30 PM
Н Н Н Н Н	Ans. (c): Lead is a material that is used to make cable sheath. The advantage of lead sheathed cable -
	1. Protection against the entry of hydrocarbon.
C - C - C - C = C - C	2. Protection against moisture.
$\begin{array}{ccccccccccc} C - & C - & C - & C \\ & & & & \\ & & H & C & H & & H \end{array}$	 2. Protection against moisture. (v) Cells and Batteries (Chargeable)
$C - C - C - C = C - C$ $ \qquad \qquad $ $H H - C - H \qquad H$	 2. Protection against moisture. (v) Cells and Batteries (Chargeable and non Chargeable)
$C - C - C - C = C - C$ $ \qquad \qquad $ $H H - C - H \qquad H$ $R \qquad R$	2. Protection against moisture. (v) Cells and Batteries (Chargeable and non Chargeable) 296 The purpose of connecting cells in series is-
$C - C - C - C = C - C$ $ \qquad \qquad $ $H H - C - H \qquad H$ $R \qquad R$ $ \qquad $ $(1) \qquad C = C - C$	 2. Protection against moisture. (v) Cells and Batteries (Chargeable and non Chargeable) 296. The purpose of connecting cells in series is— (a) to increase current rating
C - C - C - C = C - C $ $ $H H - C - H H$ $R R$ $ $ $(d) -Si - O - Si - O -$	 2. Protection against moisture. (v) Cells and Batteries (Chargeable and non Chargeable) 296. The purpose of connecting cells in series is— (a) to increase current rating (b) to make cells durable
C - C - C - C = C - C $ $ $H H - C - H H$ $R R$ $ $ $(d) -Si - O - Si - O -$ $ $	 2. Protection against moisture. (v) Cells and Batteries (Chargeable and non Chargeable) 296. The purpose of connecting cells in series is— (a) to increase current rating (b) to make cells durable (c) to increase voltage rating (d) to increase terminal voltage
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	 2. Protection against moisture. (v) Cells and Batteries (Chargeable and non Chargeable) 296. The purpose of connecting cells in series is- (a) to increase current rating (b) to make cells durable (c) to increase voltage rating (d) to increase terminal voltage RRB JE-01.09.2019
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C-C-C-C = C-C $ $ $HH-C-H H$ $R R$ $ $ $(d) -Si - O - Si - O -$ $ $ $R R$ $LMRC SCTO (Electronics) 16.04.2018, Shift-II$ Ans. (a) : The vinyl chloride molecule is C ₂ H ₃ Cl	 Protection against moisture. Cells and Batteries (Chargeable and non Chargeable) Cells and Batteries (Chargeable) The purpose of connecting cells in series is- (a) to increase current rating (b) to make cells durable (c) to increase voltage rating (d) to increase terminal voltage RRB JE-01.09.2019 RRB Chandigarh Electronic 2014 RRB Mumbai C &G JE 25.10.2009 Ans : (d) The purpose of connecting cells in series is to
C-C-C-C = C-C $ $ $HH-C-H = H$ $R = R$ $ $ $(d) -Si - O - Si - O -$ $ $ $R = R$ LMRC SCTO (Electronics) 16.04.2018, Shift-II Ans. (a) : The vinyl chloride molecule is C ₂ H ₃ Cl The chemical composition of PVC -	 2. Protection against moisture. (v) Cells and Batteries (Chargeable and non Chargeable) 296. The purpose of connecting cells in series is- (a) to increase current rating (b) to make cells durable (c) to increase voltage rating (d) to increase terminal voltage RRB JE-01.09.2019 RRB Mumbai C &G JE 25.10.2009 Ans : (d) The purpose of connecting cells in series is to increase terminal voltage
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C-C-C-C-C=C-C $ $ $HH-C-H H$ $R R$ $ $ $(d) -Si - O - Si - O -$ $ $ $R R$ $LMRC SCTO (Electronics) 16.04.2018, Shift-II$ $Ans. (a) : The vinyl chloride molecule is C2H3Cl$ The chemical composition of PVC - $H H H H$ $ $	 2. Protection against moisture. (v) Cells and Batteries (Chargeable and non Chargeable) 296. The purpose of connecting cells in series is- (a) to increase current rating (b) to make cells durable (c) to increase voltage rating (d) to increase terminal voltage RRB JE-01.09.2019 RRB Chandigarh Electronic 2014 RRB Mumbai C &G JE 25.10.2009 Ans : (d) The purpose of connecting cells in series is to increase terminal voltage
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$\begin{array}{cccccccccccccccccccccccccccccccccccc$	 2. Protection against moisture. (v) Cells and Batteries (Chargeable and non Chargeable) 296. The purpose of connecting cells in series is- (a) to increase current rating (b) to make cells durable (c) to increase voltage rating (d) to increase terminal voltage RRB Chandigarh Electronic 2014 RRB Mumbai C &G JE 25.10.2009 Ans : (d) The purpose of connecting cells in series is to increase terminal voltage R R R R R R R R
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C - C - C - C = C - C $ $ $H H - C - H H$ $R R$ $ $ $(d) -Si - O - Si - O -$ $ $ $R R$ $LMRC SCTO (Electronics) 16.04.2018, Shift-II$ $Ans. (a) : The vinyl chloride molecule is C2H3Cl The chemical composition of PVC -$ $H H H H H$ $ $ CCC $ $ $Cl H Cl H$ Polyvinyl Chloride is a synthetic polymer which is formed by combining two chemical repeatedly to form a	 2. Protection against moisture. (v) Cells and Batteries (Chargeable and non Chargeable) 296. The purpose of connecting cells in series is- (a) to increase current rating (b) to make cells durable (c) to increase voltage rating (d) to increase terminal voltage RRB Chandigarh Electronic 2014 RRB Mumbai C &G JE 25.10.2009 Ans : (d) The purpose of connecting cells in series is to increase terminal voltage (i) iiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiiii



generates free electrons and holes. Due to which the resistance of the material decrease continuously.	 311. Which of the following batteries does not require trickle charging? (a) Lead acid cell (b) Alkaline cell (c) Lead acid and Alkaline cell both (d) Neither lead acid nor alkaline cell Konkan Railway STA 2017
When no light fall on it then the resistance of this material is very high and the current flow very less.	Ans : (b) An alkaline cell/battery does not require trickle charging. Since in this electrolyte is potassium hydroxide (KOH). During the discharging of battery it is resolved into K^+ and OH^- ions.
 (a) Silicon (b) Selenium (c) Platinum (d) Germanium (e) DMRC Electronics 17.02.2017, 8:30 to 10:45 AM 	 312. Identify the false statement : (a) A Primary cell is non rechargeable and cannot be reused. (b) Dry cells are light weight and small.
 Ans. (a) : Silicon is used in the active layer of a photovoltaic cell. Photovoltaic cell is a P-N junction semiconductor device, which convert photon energy into electrical energy. 	(c) Nickel cadmium cell is an example of primary cell.(d) Dry cell is an electrochemical cell consisting of low moisture immobilized electrolytes in
 Photovoltaic cell commonly used in satellite communication for power supply. Photovoltaic cells are also called "solar cell". 308. Cells are connected in parallel to : 	Ans. (c) : Nickel–cadmium cell is an example of secondary cell and is a type of rechargeable cell. Nickel
 (a) increase the current capacity (b) terminal voltage (c) increase the life of the cells (d) increase the voltage rating 	Joxide and metallic cadmium use as electrodes in battery.313. Which of the following is the normal cell voltage of a lithium ion battery?(a) 1.5 V(b) 2.5 V
Ans. (a) :Since a cell have some internal resistance and when it is connected in parallel then total effective resistance of the cell become small or less ocurrent of	(c) 1.2 V (d) 3.6 V UPMRC (SCTO) 14.04.2021 Konkan Railway TA-2017 Ans. (d) : The normal cell voltage of a lithium ion
the cell increases. Therefore cells are connected in parallel to increase the current capacity.	battery is 3.6V. Primary battery Voltage rating
309. Ampere Hour is the unit for measuring- (a) Power of the meter (b) Energy (c) Capacity of a cell (d) None of these	Mercury Battery1.35 VCarbon Battery1.5 VSilver oxide cell1.5 V
DMRC JE 20.04.2018 Ans. (c) : Ampere-hour term is defined for the capacity of a battery. It is the ratio of ampere hour during discharging to charging.	 314. Which is the appropriate combination of primary cell: secondary cell. (a) Carbon-Zinc : Manganese-Alkaline (b) Mercury : Silver-Oxide
$\% \text{ Ampere - hour efficiency} = \frac{\text{Ampere hour during discharging}}{\text{Ampere hour during charging}} \times 100$	(c) Manganese-Alkaline : Lead-Acid (d) None of these Konkon Pailwa TA 2017
 310. Which of the following laws governs electrolysis applications? (a) Ohm's law (b) Coulomb's law (c) Faraday's law (d) Lenz's law DMPC LE 20.04 2018 	Ans. (c) Primary cellSecondary cellMaganese alkalineLead AcidCarbon ZincNickel - ironZinc chlorideNickel cadmium
Ans. (c) : Faraday's law governs electrolysis applications. According to faraday's law of electrolysis, the amount of chemical reaction which occurs at any electron under the influence of electrical energy is	Silver oxideSilver zinc 315. Ampere hour capacity of a battery used in telecom industry has the discharge rate of (a) 10 hrs(b) 12 hrs
proportional to the quantity of electricity passed through the electrolyte.	(c) 16 hrs (d) 5 hrs Konkan Railway TA-2017
$m \propto Q$ m \approx It m = ZIt	Ans. (a) : Ampere-hour capacity of a battery used in telecom industry has the discharge rate of 10 hrs. There are mainly two types of battery used in telecoms industry–
Where, Z = Proportionality constant t = Time for which current flow I= flow of current m = Weight of substance/chemical.	 (1) Lead acid battery (2) Li-Ion battery. These are rechargeable batteries, because these have the reversible chemical action.



(d) Temperature $UPMRC JE_2 20.01.2020 4.00 to 6.00 PM$	332. During charging of lead acid batteries the vent plug is to be (a) Kent closed
RRB Allahabad SSE 09.09.2012	(b) Removed
RRB Patna Technical Engg27.07.2008	(c) Removed or kept closed depending on room
Ans. (c) : The efficiency of a lead acid cell depends on-	(d) Removed or kept closed depending on
(1) Internal resistance (2) Pata of charging and discharging	duration of charge
(2) Kale of charging and discharging (3) Temperature	RRB Chandigarh SSE-09.09.2012
But does not depends on pressure	Ans. (b) : During charging of lead acid batteries the
327. Petroleum jelly is applied to the terminals of	vent plug is to be removed.
the lead acid battery to prevent	gases formed like hydrogen and oxygen when the
(a) Local heating (b) Corrosion	battery is charging.
(c) Short circuiting (d) All of the above	333. The output voltage of a cell changes when a
KKB Bangalore SSE 09.09.2012	current is drawn from the cell due to,
lead acid battery to prevent corrosion because the	(a) Internal resistance (b) Decrease in load resistance
petroleum jelly is a hydrophobic material.	(c) Inductance of the connected load
328. Which of the following is dry but rechargeable	(d) Depth of discharge of the cell
cell?	RRB Jammu SSE 09.09.2012
(a) Solar cell (b) Lord agid call & Niekal and mium call	Ans. (a) : The output voltage of a cell changes when a
(c) Lead acid cell	current is drawn from the cell due to internal resistance
(d) Nickel-Cadmium cell	(a) cathode and anode both
NMRC Electronics 14.09.2019, 12:00 – 2:15 PM	(b) outside the electrolyte chamber
RRB Bangalore SSE-09.09.2012	(c) anode
Ans. (a) : The Nickel-cadmium cell is a dry cell but it is rechargeable. Because it has the reversible chemical action	(d) cathode
so it charges and discharges. In this negative plates are made	Ans · (c) In dry cells free electrons are released at
up of mixture of cadmium oxide and positive plate is made	anode. Dry cell is called carbon zinc cell. In Dry cell
up of Ni(OH) ₄ .	Negative plate is made of zinc electrode. and positive
329. Which of the following is an example of a dry	plate is carbon electrode. which will produce a
(a) Lead acid battery (b) Voltaic cell	335. The resistance of the conductor in the
(c) Carbon zinc cell (d) Nickel iron battery	electrolytic cell with an increase in
DMRC JE 09.04.2018	temperature.
Ans. (c) : The dry cell store chemical to convert	(a) Increase (b) Decrease (c) Slightly increase (d) Do not change
cell is 6mm×2.5mm. An example of a dry cell is carbon	RRB Jammu SSE 09.09.2012
zinc cell.	Ans. (b) : The resistance of the conductor in the
330. The most common used primary cell is :	electrolytic cell decreases with increase in the
(a) $T_{14}^{(1)}$ (b) $T_{14}^{(1)}$ (c) $T_{14}^{(1)}$ (c) $T_{14}^{(1)}$ (c) $T_{14}^{(1)}$ (c) $T_{14}^{(1)}$	Themperature in merature conductors resistance of mer
(a) Litnium cell (b) Nickel-Iron cell	conductor increases with increases in temperature.
(a) Lithium cell (b) Nickel-Iron cell (c) Lead acid cell (d) Nickel cadmium cell PBP Bhanal SSE 00 00 2012	conductor increases with increases in temperature. 336. The main advantage of nickel-iron battery over
(a) LITHIUM CEII (b) NICKEI-ITON CEII (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium	 336. The main advantage of nickel-iron battery over lead acid battery is that
(a) Lithium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell.	 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much chemer
(a) Lithium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics-	 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency
(a) Lithium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics- (1) It has long life	 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency (d) It has higher cell voltage
 (a) Lithium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics- (1) It has long life (2) It has high energy density (3) It has uplage near about 2.05V 	 conductor increases with increases in temperature. 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency (d) It has higher cell voltage RRB Bhubaneswar JE-II, 29.11.2008
 (a) Litnium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics- (1) It has long life (2) It has high energy density (3) It has voltage near about 2.95V. (4) It is widely used in portable electronic devices 	 conductor increases with increases in temperature. 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency (d) It has higher cell voltage RRB Bhubaneswar JE-II, 29.11.2008 RRB Patna Technical Engg. 27.07.2008
 (a) Lithium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics- (1) It has long life (2) It has high energy density (3) It has voltage near about 2.95V. (4) It is widely used in portable electronic devices. 331. Trickle charging of storage battery helps to	 in the data conductors, resistance of the conductor increases with increases in temperature. 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency (d) It has higher cell voltage RRB Bhubaneswar JE-II, 29.11.2008 RRB Patna Technical Engg. 27.07.2008 Ans. (a) : Advantages of nickel-iron battery over lead acid battery
 (a) Lithium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics- (1) It has long life (2) It has high energy density (3) It has voltage near about 2.95V. (4) It is widely used in portable electronic devices. 331. Trickle charging of storage battery helps to	 conductor increases with increases in temperature. 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency (d) It has higher cell voltage RRB Bhubaneswar JE-II, 29.11.2008 RRB Patna Technical Engg. 27.07.2008 Ans. (a) : Advantages of nickel-iron battery over lead acid battery Lead acid Battery Nickel-Iron Battery
 (a) Litnium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics- (1) It has long life (2) It has high energy density (3) It has voltage near about 2.95V. (4) It is widely used in portable electronic devices. 331. Trickle charging of storage battery helps to (a) prevent sulphation 	conductor increases with increases in temperature. 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency (d) It has higher cell voltage RRB Bhubaneswar JE-II, 29.11.2008 RRB Patna Technical Engg. 27.07.2008 Ans. (a) : Advantages of nickel-iron battery over lead acid battery Lead acid Battery Nickel-Iron Battery (1) A-h efficiency is
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 (a) Lithium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics- (1) It has long life (2) It has high energy density (3) It has voltage near about 2.95V. (4) It is widely used in portable electronic devices. 331. Trickle charging of storage battery helps to 	conductor increases with increases in temperature. 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency (d) It has higher cell voltage RRB Bhubaneswar JE-II, 29.11.2008 RRB Patna Technical Engg. 27.07.2008 Ans. (a) : Advantages of nickel-iron battery over lead acid battery Lead acid Battery Nickel-Iron Battery (1) A-h efficiency is maximum (2) Efficiency is 90-95%
 (a) Litnium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics- (1) It has long life (2) It has high energy density (3) It has voltage near about 2.95V. (4) It is widely used in portable electronic devices. 331. Trickle charging of storage battery helps to 	conductor increases with increases in temperature. 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency (d) It has higher cell voltage RRB Bhubaneswar JE-II, 29.11.2008 RRB Patna Technical Engg. 27.07.2008 Ans. (a) : Advantages of nickel-iron battery over lead acid battery Lead acid Battery Nickel-Iron Battery (1) A-h efficiency is A-h efficiency is less maximum (2) Efficiency is 90-95% efficiency is 72 to 80% (3) Average emf is Average voltage is 2V/cell
 (a) Litnium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics- (1) It has long life (2) It has high energy density (3) It has voltage near about 2.95V. (4) It is widely used in portable electronic devices. 331. Trickle charging of storage battery helps to	conductor increases with increases in temperature. 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency (d) It has higher cell voltage RRB Bhubaneswar JE-II, 29.11.2008 RRB Patna Technical Engg. 27.07.2008 Ans. (a) : Advantages of nickel-iron battery over lead acid battery Lead acid Battery Nickel-Iron Battery (1) A-h efficiency is A-h efficiency is less maximum (2) Efficiency is 90-95% efficiency is 72 to 80% (3) Average emf is Average voltage is 2V/cell (4) High maintenance
 (a) Litnium cell (b) Nickel-iron cell (c) Lead acid cell (d) Nickel cadmium cell RRB Bhopal SSE-09.09.2012 Ans : (a) The most common used primary cell is lithium cell. Some special characteristics- It has long life It has long life It has voltage near about 2.95V. (4) It is widely used in portable electronic devices. 331. Trickle charging of storage battery helps to (a) prevent sulphation (b) keep it fresh and fully charged (c) maintain proper electrolyte level (d) increase its reserve capacity RRB Bhopal SSE 09.09.2012 Ans : (b) Trickle charging of storage battery helps to keep it fresh and fully charged. 	conductor increases with increases in temperature. 336. The main advantage of nickel-iron battery over lead acid battery is that (a) It needs less maintenance (b) It is much cheaper (c) It has higher efficiency (d) It has higher cell voltage RRB Bhubaneswar JE-II, 29.11.2008 RRB Patna Technical Engg. 27.07.2008 Ans. (a) : Advantages of nickel-iron battery over lead acid battery Lead acid Battery Nickel-Iron Battery (1) A-h efficiency is maximum (2) Efficiency is 90-95% efficiency is 72 to 80% (3) Average emf is Average voltage is 2V/cell 1.2V/cell (4) High maintenance

337. Carbon electrodes are used in. Ans : (c) The emf of a cell is that maximum voltage (1) GLS Lamp which is the potential difference between open terminal (2) Dry cell of the circuit. The emf. of a cell depends upon-(3) Arc furnace (1) Nature of electrodes temperature, Which of the following is correct? (2) Electrodes of the cell (a) Only 1 (b) 2 and 3 (3) Nature of electrolyte (c) 1 and 3 (d) 1. 2 and 3 342. In a step-up transformer, the turn's ratio is 1:2. **DFCCIL EE 17.04.2016, Shift-II** A Leclanche cell (emf 1.5V) is connected across **RRB Bhubaneswar JE-II, 29.11.2008** the primary. The voltage across the secondary Ans. (b) : Carbon electrodes are used in dry cell and arc is-(b) 0.75V furnace (a) 3.0V In dry cell negative plate is made up of zinc electrode (c) 0V (d) 1.5V and positive plate is made up of carbon electrodes. In RRB Bangalore SSE 01.02.2009 any furnace carbon electrodes are used to produce arc in Ans: (c) Leclanche cell only operate for D.C. circuit, It the furnace. only give the D.C. supply to the transformer. Hence 338. If 24 cells of 2V each are connected in parallel, transformer can not operate for this small D.C. voltage the terminal voltage is (1.5V) and hence voltage induced on secondary side (b) 12V (a) 2V would be zero. (d) 48V (c) 24V 343. A solar cell is an example of **RRB Bhubaneswar JE-II, 29.11.2008** (a) Photo conduction cell (b) Photo emission cell **RRB Patna Technical Engg.27.07.2008** (c) Photo radiation cell (d) Photo voltaic cell Ans. (a) : According to question connection of cell **DMRC Secunderabad SSE 29.06.2008** given in figure below-**RRB Chandigarh SSE 15.03.2009** Ans. (d) : Solar cell is an example of photo voltaic cell because it converts light energy of sun into electrical energy. Voltage induced by photo voltaic cell depends $2V_{\parallel}$ on the effect of light intensity. It is directly proportional to intensity of light. It is made up of semiconductor materials. 2V 24 344. The e.m.f. of a cell depends upon (a) The internal resistance Since all the cells are connected in parallel and in (b) External resistance parallel connection voltage across each element are (c) Electrolyte and electrodes of the cell same hence the terminal voltage will be 2 volt. (d) None of the factors 339. A solar cell is an example of **RRB Bangalore Technical Engg. 22.04.2007** (a) Photo conduction cell (b) Photo emission cell **RRB Chandigarh SSE 26.02.2012** (c) Photo radiation cell (d) Photo voltaic cell Ans : (c) The emf of a cell is that maximum voltage **RRB Bhubaneswar JE-II, 29.11.2008** which is the potential difference between open terminal Ans. (d) : Solar cell is an example of photo voltaic cell of the circuit. The emf. of a cell depends uponbecause it converts light energy of sun into electrical (1) Nature of electrodes temperature, energy. Voltage induced by photo voltaic cell depends (2) Electrodes of the cell on the effect of light intensity. It is directly proportional (3) Nature of electrolyte to intensity of light. It is made up of semiconductor 345. The battery will get warm, when we try to send materials. too much current through battery. This is 340. Which of the following is not a primary cell? mainly due to? (a) Carbon-zinc (b) Alkaline (a) Battery manufacturing defect (c) Zinc-chloride (d) Lead-acid (b) Due to defect of connected load **RRB Bhopal SSE -24.11.2002** (c) Internal resistance of the battery **RRB Patna Technical Engg.-27.07.2008** (d) None Ans. (d) : A cell in which chemical action is not RRB Kolkata Engg. 20.02.2000 reversible is called a primary cell. Primary cell is a Ans : (c) The battery will get warm, when we try to single used power source. There are different type of send too much current through the battery. This is primary cellmainly due to internal resistance of the battery and it is (1) Carbon-zinc (2) Alkaline (3) Zinc-chloride But lead acid cell is a secondary cell because it has the given by- $|H = I^2 Rt$ reversible chemical action. W 341. The e.m.f. of a cell depends upon Voltage Internal (a) The internal resistance source resistance (b) External resistance (c) Electrolyte and electrodes of the cell (d) None of the factors (Battery) **RRB Bangalore SSE 01.02.2009**